

(V) Preliminary Specification
() Final Specification

Module	17" Color TFT-LCD
Model Name	P170ETN01.0

Customer _____ Date _____	Approved by <u>CT Wu</u> Date <u>Jan. 15, 2021</u>
Approved by _____ Date _____	Prepared by <u>Sophie Teng</u> Date <u>Jan. 15, 2021</u>
Note: This Specification is subject to change without notice.	ADP Display Plus Corporation

Contents

1 Handling Precautions.....	4
2 General Description.....	5
2.1 Display Characteristics.....	5
2.2 Absolute Maximum Rating of Environment.....	6
2.3 Optical Characteristics.....	7
3.2 Interface Connection.....	12
3.2.1 Connector Type.....	12
3.2.2 Connector Pin Assignment.....	12
3.3 Electrical Characteristics.....	14
3.3.1 Absolute Maximum Rating.....	14
3.3.2 Recommended Operating Condition.....	14
3.4 Signal Characteristics.....	15
3.4.1 LCD Pixel Format.....	15
3.4.2 LVDS Data Format.....	15
3.4.3 Color versus Input Data.....	16
3.4.4 LVDS Specification.....	17
3.4.5 Input Timing Specification.....	19
3.4.6 Input Timing Diagram.....	21
3.5 Power ON/OFF Sequence.....	22
4 Backlight Unit.....	24
4.1 Block Diagram.....	24
4.2 Interface Connection.....	25
4.2.1 Connector Type.....	25
4.2.2 Connector Pin Assignment.....	26
4.3.1 Absolute Maximum Rating.....	27
4.3.2 Recommended Operating Condition.....	27
5 Reliability Test.....	28
6 Shipping Label.....	30
7 Mechanical Characteristics.....	31
8 Packing Specification.....	32
8.1 Packing Flow.....	32
8.2 Pallet and shipment information.....	33

Record of Revision

Version	Date	Page	Old description	New Description	Remark
0.0	2021/1/15	All	First version	-	

Tel: +86 13728663670
Email: andeic@andesource.com
www.andesource.com

I Handling Precautions

- 1) Since polarizer is easily damaged, do not touch or press the surface of polarizer with hand.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open or modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) In case a TFT-LCD Module has to be put back into the packing container slot after once it was taken out from the container, do not press the center of the LED lightbar edge. Otherwise the TFT-LCD Module may be damaged.
- 10) Insert or pull out the interface connector, be sure not to rotate nor tilt it of the TFT-LCD Module.
- 11) Do not twist nor bend the TFT -LCD Module even momentary. It should be taken into consideration that no bending/twisting forces are applied to the TFT-LCD Module from outside. Otherwise the TFT-LCD Module may be damaged.
- 12) Please avoid touching COF position while you are doing mechanical design.
- 13) When storing modules as spares for a long time, the following precaution is necessary:
Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.
- 14) Do not apply the same pattern for a long time, it will enhance relevant defect.
- 15) When this reverse-type model(PCBA on bottom side) is used as forward-type model(PCBA on top side) , ADP can not guarantee any defects of LCM.



2 General Description

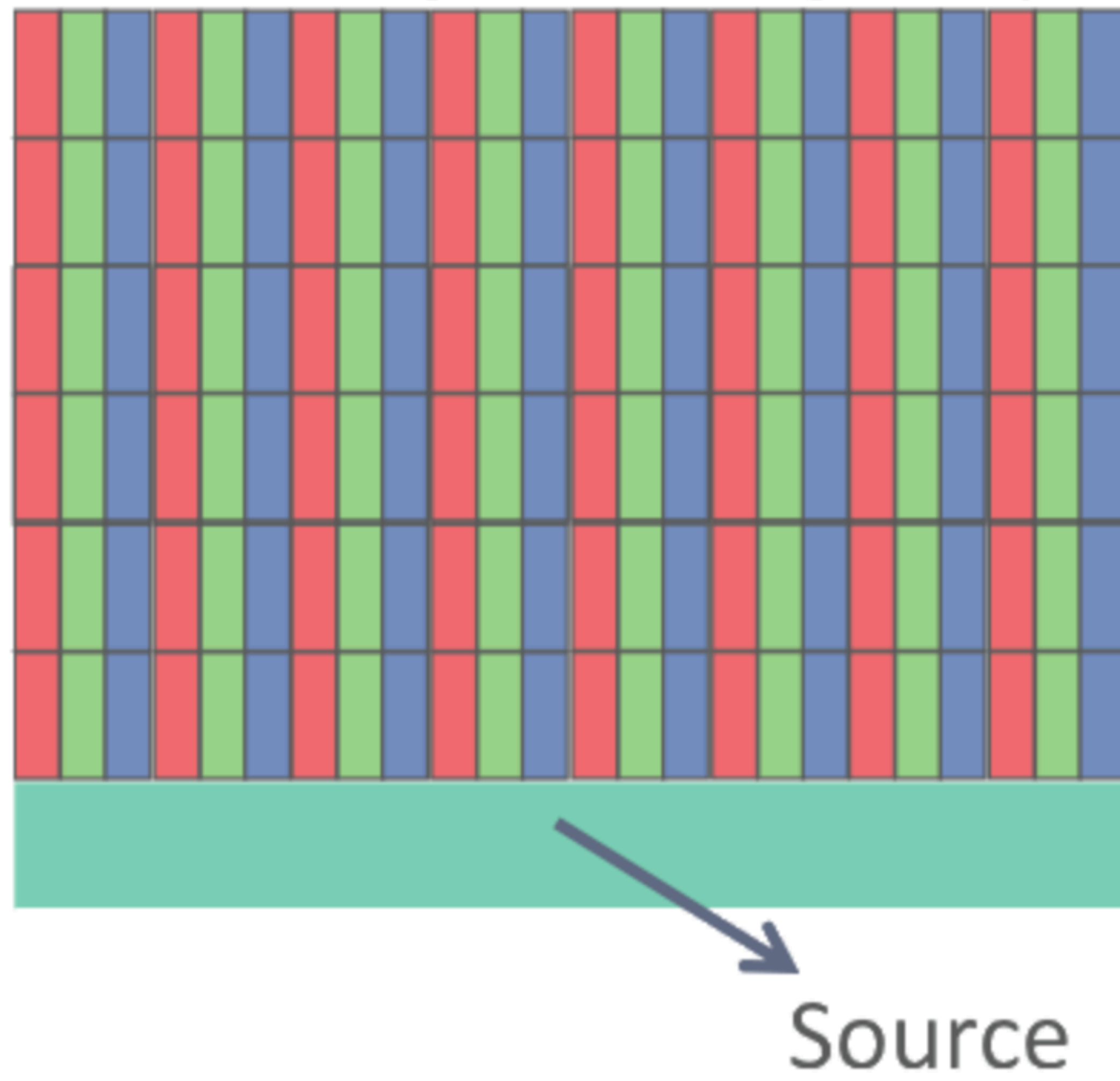
This specification applies to the 17 inch wide Color a-Si TFT-LCD Module P170ETN01.0. The display supports the SXGA+ (1280(H) x 1024(V)) screen format and 16.7M colors (8bits RGB data input). The input interface is Dual channel LVDS and this module doesn't contain a driver board for backlight.

2.1 Display Characteristics

The following items are characteristics summary on the table under 25°C condition:

ITEMS	Unit	SPECIFICATIONS
Screen Diagonal	[mm]	432 (17.0")
Active Area	[mm]	337.92(H) × 270.34(V)
Pixels H x V	-	1280 × 3(RGB) × 1024
Pixel Pitch	[mm]	0.264(per one triad) × 0.264
Pixel Arrangement	-	R.G.B. Vertical Stripe <i>Note 2-1</i>
Display Mode	-	Normally White
White Luminance (Center)	[cd/m ²]	250 (Typ.)
Contrast Ratio	-	1000 : 1 (Typ.)
Response Time	[msec]	5 (Typ., on/off)
Power Consumption (LCD Module + Backligh unit)	[Watt]	7.5W (Typ.) LCD module : PDD (Typ.)=3W @ Black pattern,Fv=60Hz Backlight unit : PBLU (Typ.) =4.5 W @Is=45 mA
Weight	[Grams]	1270 (Typ.)
Outline Dimension	[mm]	358.5(H) × 296.5(V) × 10.3(D) (Typ.)
Electrical Interface	-	Dual Channel LVDS(8bits RGB data input)
Support Color	-	16.7M colors
Surface Treatment	-	Anti-glare type, Hardness 3H
Temperature Range Operating Storage (Shipping)	[°C] [°C]	0 to +50 -20 to +60
RoHS Compliance	-	RoHS Compliance
TCO Compliance	-	TCO8.0 Compliance

Note 2-1: The following shows the figure of pixel arrangement



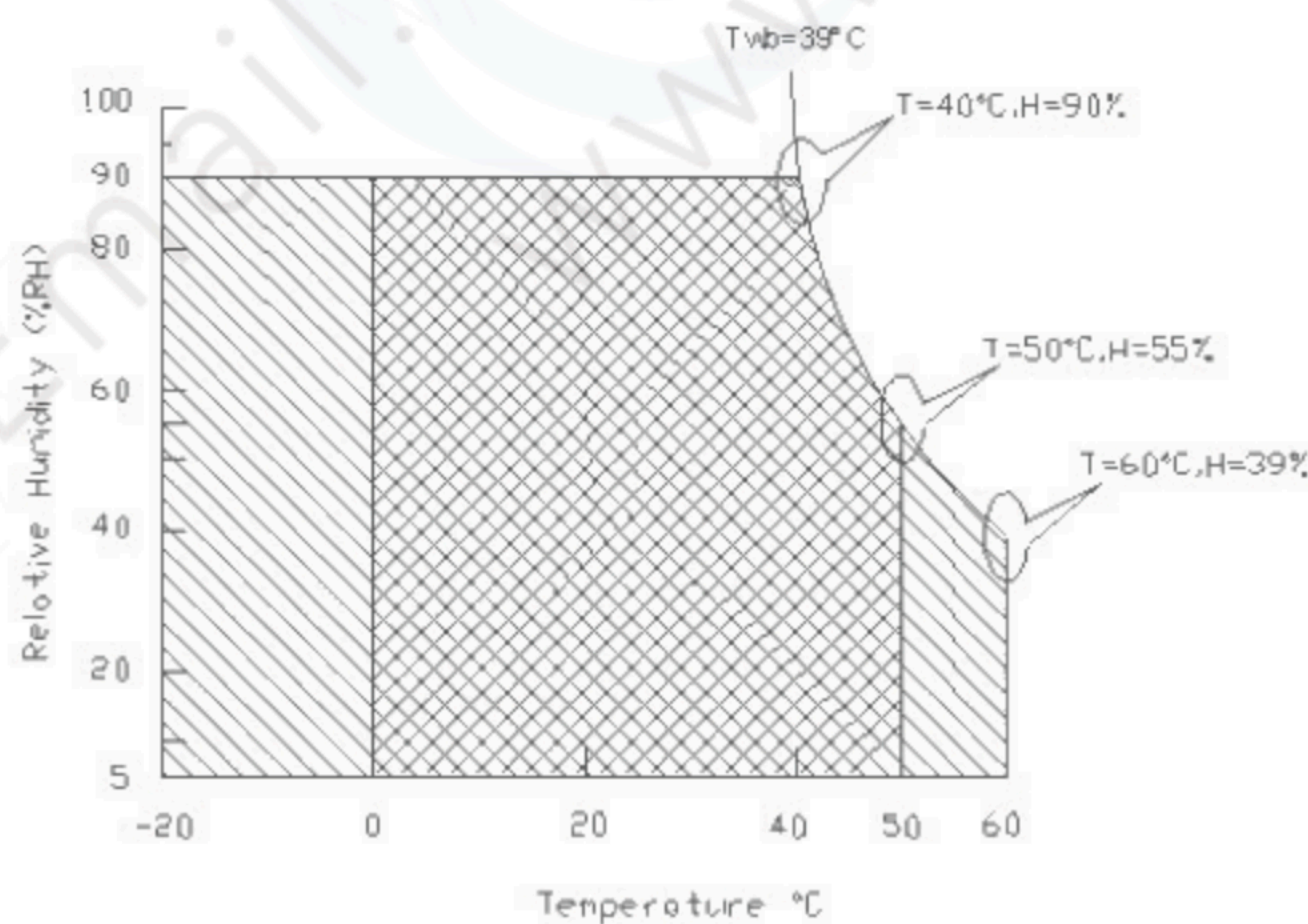
2.2 Absolute Maximum Rating of Environment

Permanent damage may occur if exceeding the following maximum rating.

Symbol	Description	Min.	Max.	Unit	Remark
TOP	Operating Temperature	0	+50	[°C]	Note 2-2
TGS	Glass surface temperature (operation)	0	+65	[°C]	Note 2-2 Function judged only
HOP	Operation Humidity	5	90	[%RH]	Note 2-2
TST	Storage Temperature	-20	+60	[°C]	
HST	Storage Humidity	5	90	[%RH]	

Note 2-2: Temperature and relative humidity range are shown as the below figure.

1. 90% RH Max ($T_a \leq 39^\circ\text{C}$)
2. Max wet-bulb temperature at 39°C or less. ($T_a \leq 39^\circ\text{C}$)
3. No condensation



Operating Range

Storage Range



2.3 Optical Characteristics

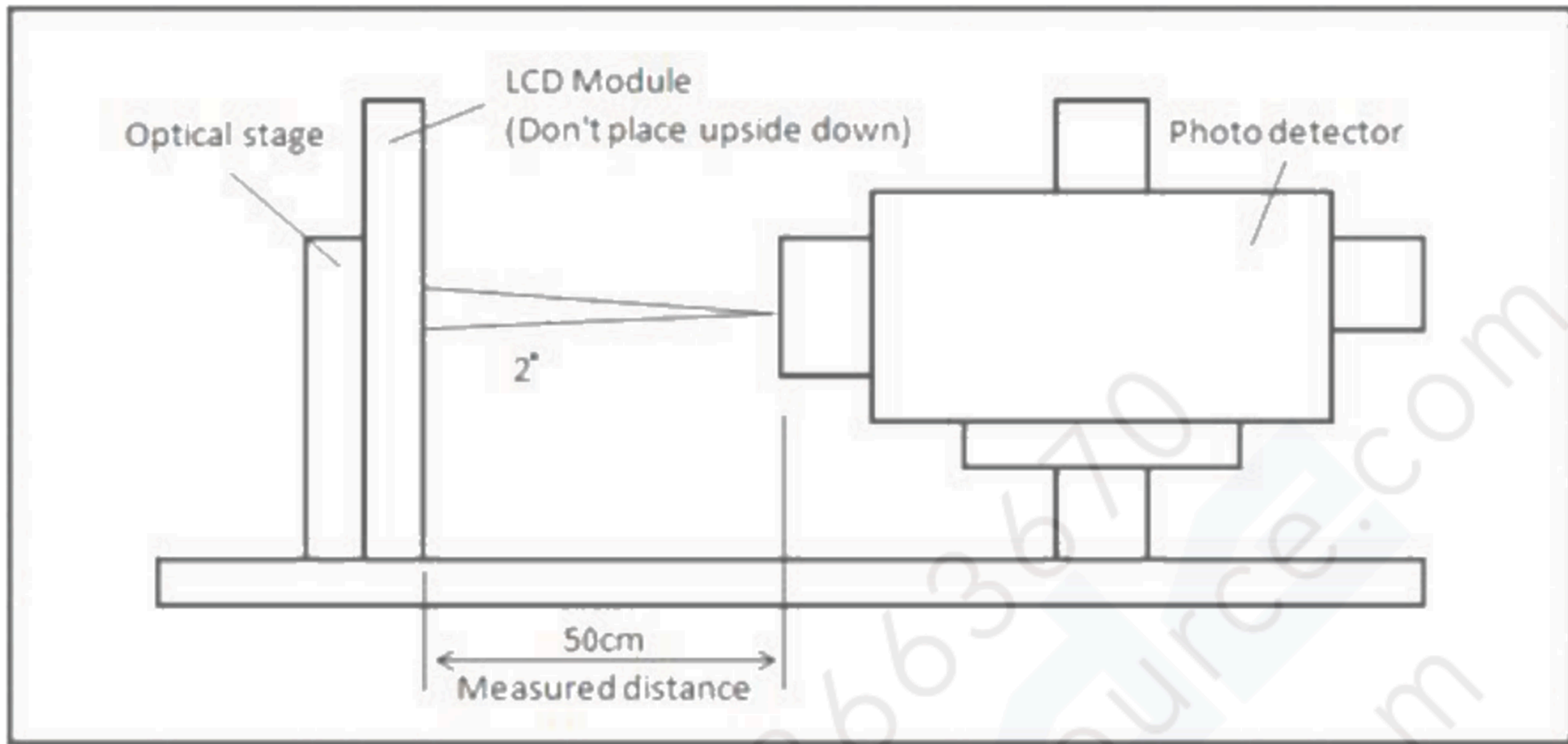
The optical characteristics are measured on the following test condition.

Test Condition:

1. Equipment setup: Please refer to **Note 2-3**.
2. Panel Lighting time: 30 minutes
3. VDD=5.0V, Fv=60Hz, Is=45mA, Ta=25 °C

Symbol	Description		Min.	Typ.	Max.	Unit	Remark
L _w	White Luminance (Center of screen)		200	250	-	[cd/m2]	<i>Note 2-3</i> <i>By SR-3</i>
L _{uni}	Luminance Uniformity (9 points)		75	80	-	[%]	<i>Note 2-4</i> <i>By SR-3</i>
CR	Contrast Ratio (Center of screen)		600	1000	-	-	<i>Note 2-5</i> <i>By SR-3</i>
θ _R	Horizontal Viewing Angle (CR=10)	Right	75	85	-	[degree]	<i>Note 2-6</i> <i>By SR-3</i>
θ _L		Left	75	85	-		
Φ _H	Vertical Viewing Angle (CR=10)	Up	70	80	-		
Φ _L		Down	70	80	-		
θ _R	Horizontal Viewing Angle (CR=5)	Right	75	88	-		
θ _L		Left	75	88	-		
Φ _H	Vertical Viewing Angle (CR=5)	Up	70	85	-		
Φ _L		Down	70	85	-		
T _R	Response Time	Rising Time	-	3.8	5.5	[msec]	<i>Note 2-7</i> <i>By TRD-100</i>
T _F		Falling Time	-	1.2	2.5		
-		Rising + Falling	-	5	8		
R _x	Color Coordinates (CIE 1931)	Red x	0.616	0.646	0.676	-	<i>By SR-3</i>
R _y		Red y	0.306	0.336	0.366		
G _x		Green x	0.289	0.319	0.349		
G _y		Green y	0.591	0.621	0.651		
B _x		Blue x	0.123	0.153	0.183		
B _y		Blue y	0.032	0.062	0.092		
W _x		White x	0.283	0.313	0.343		
W _y		White y	0.299	0.329	0.359		
NTSC				72		[%]	<i>By SR-3</i>

Note 2-3: Equipment setup :

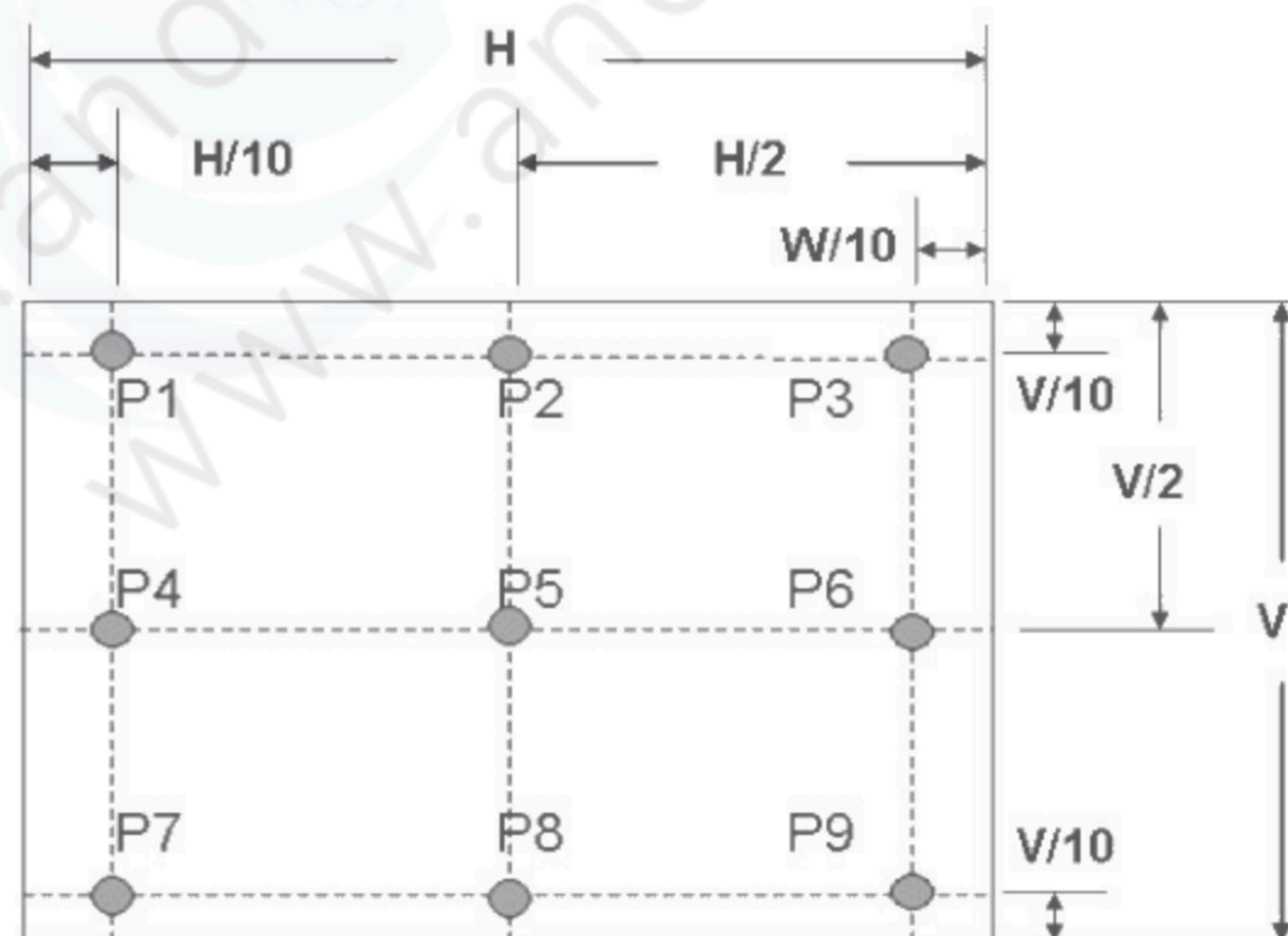


Note 2-4: Luminance Uniformity Measurement

Definition:

$$\text{Luminance Uniformity} = \frac{\text{Minimum Luminance of 9 Points (P1 ~ P9)}}{\text{Maximum Luminance of 9 Points (P1 ~ P9)}}$$

a. Test pattern: White Pattern



Note 2-5: Contrast Ratio Measurement

Definition:

$$\text{Contrast Ratio} = \frac{\text{Luminance of White pattern}}{\text{Luminance of Black pattern}}$$

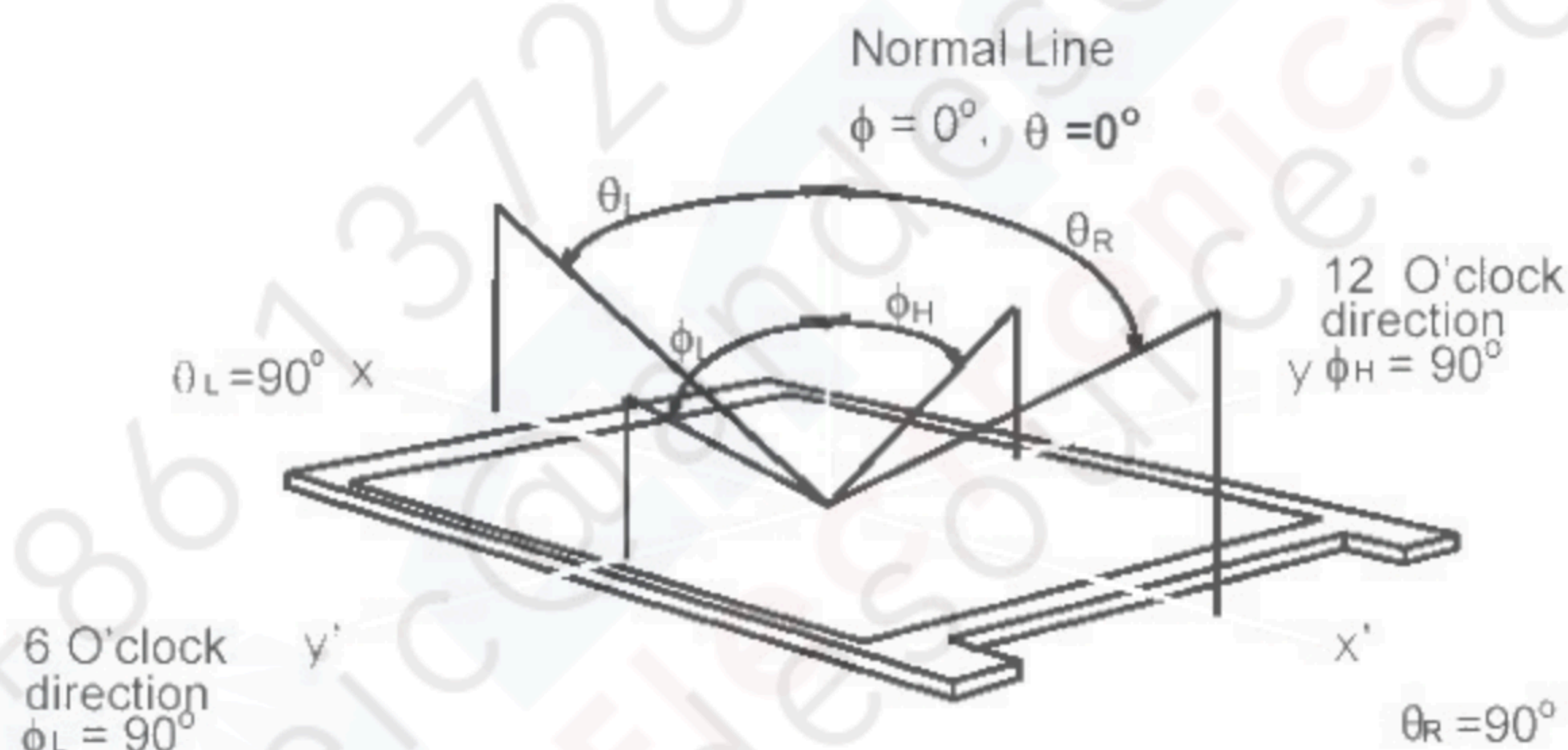
- a. Measured position: Center of screen (P5) & perpendicular to the screen ($\theta = \Phi = 0^\circ$)

Note 2-6: Viewing angle measurement

Definition: The angle at which the contrast ratio is greater than 10 & 5.

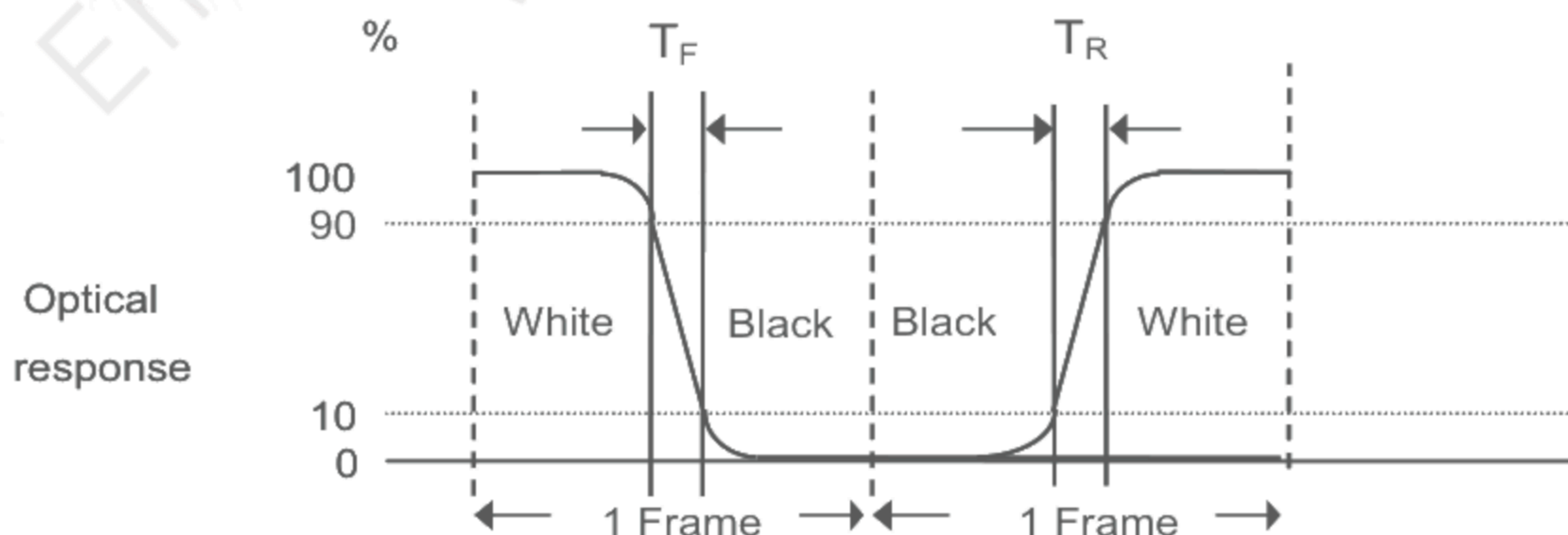
- a. Horizontal view angle: Divide to left & right (θ_L & θ_R)

Vertical view angle: Divide to up & down (Φ_H & Φ_L)



Note 2-7: Response time measurement

The output signals of photo detector are measured when the input signals are changed from “Black” to “White” (rising time, T_R), and from “White” to “Black” (falling time, T_F), respectively. The response time is interval between the 10% and 90% of optical response. (*Black & White color definition: Please refer section 3.4.3*)



2.4 Mechanical Characteristics

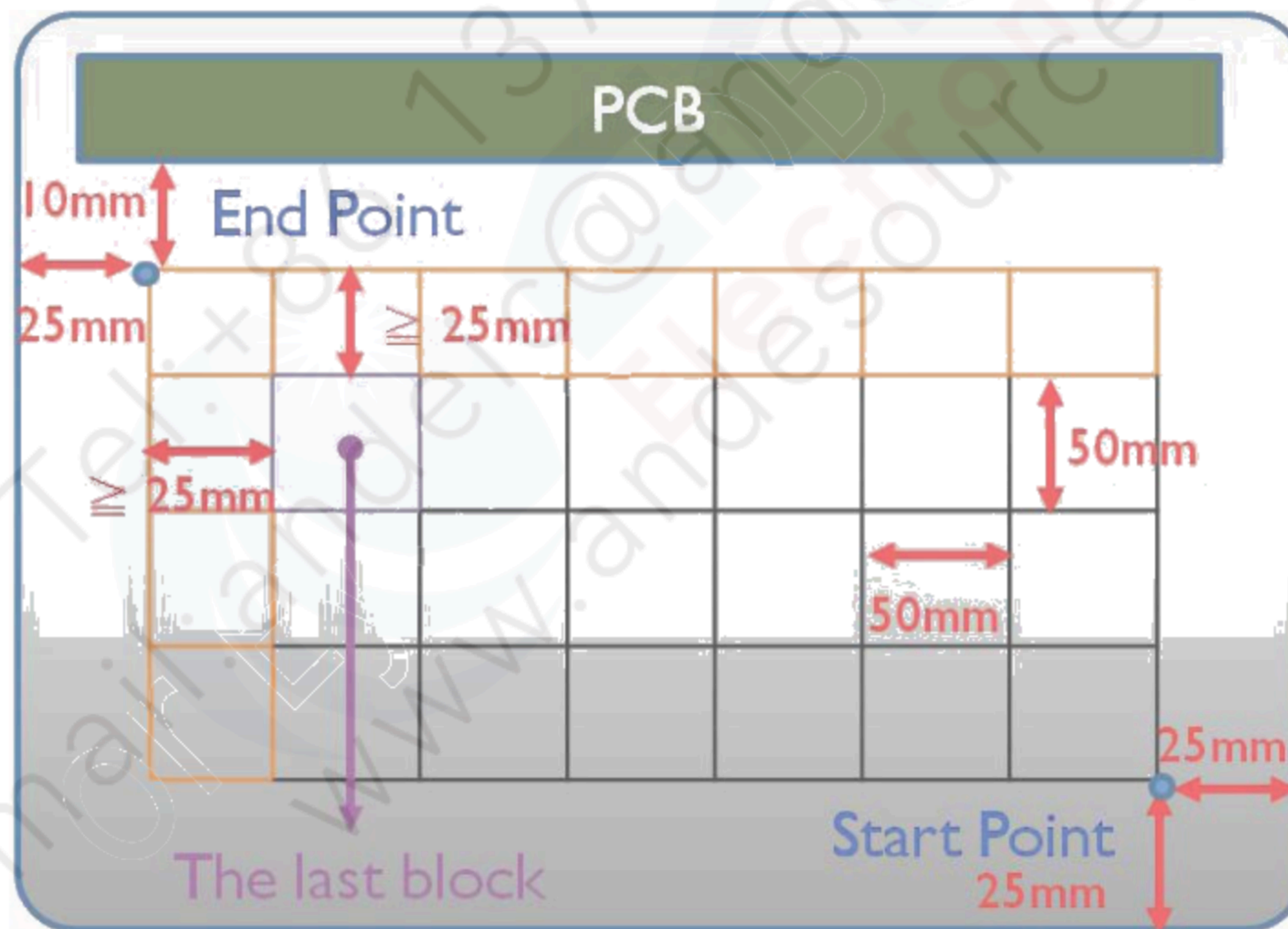
Symbol	Description	Min.	Max.	Unit	Remark
P_{bc}	Backside Compression	2.5	-	[Kgf]	<i>Note 2-10</i>

Note 2-10: Test Method:

The point is at a distance from right-downside 25mm x 25mm defined as the Start Point of Measure Points, and the point is at a distance 25mm from left-side & around 10mm from PCB defined as the End Point.

Align 50mm x 50mm block from Start Point on the Bezel Back, and the corners of each block are Measure Points.

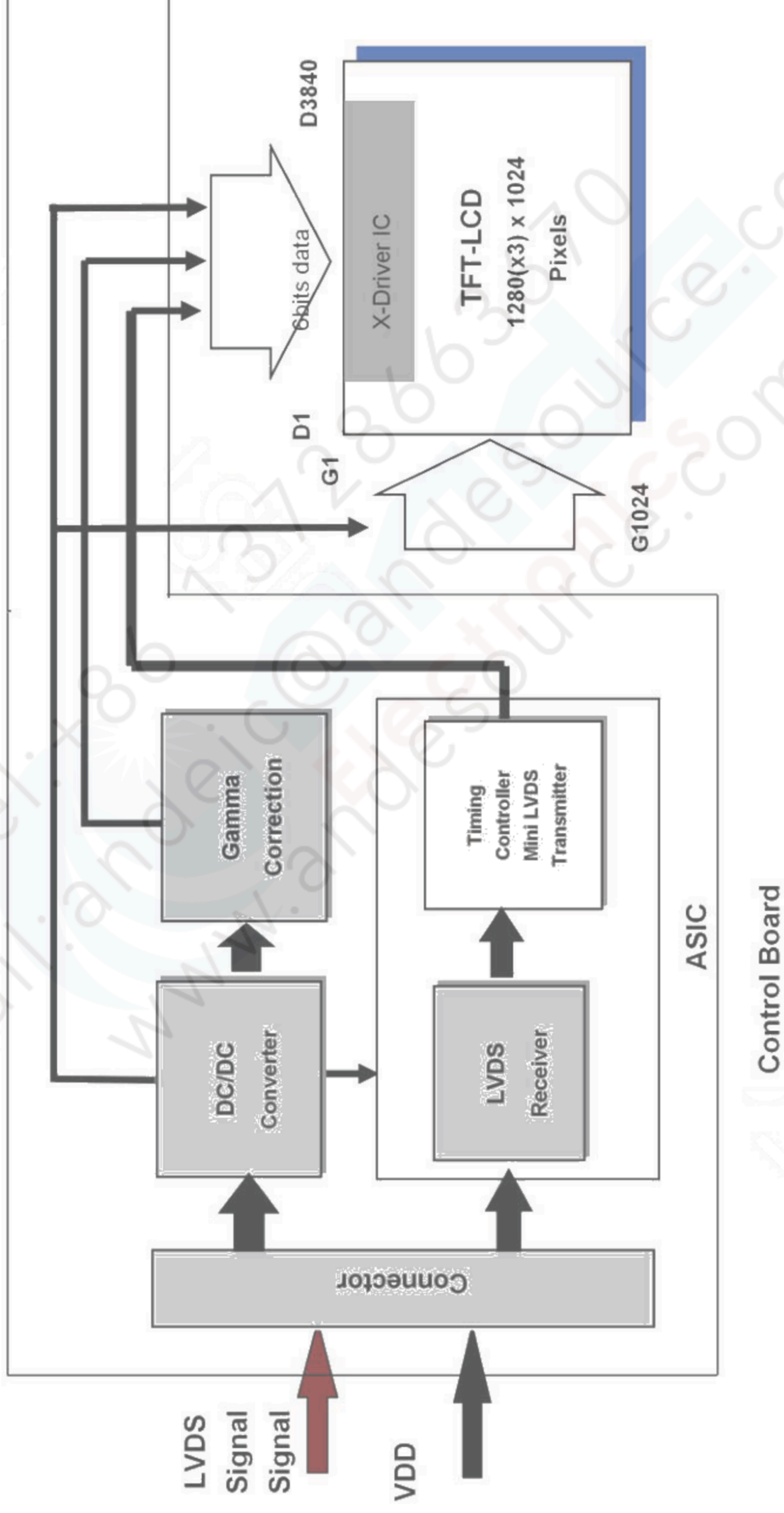
If the distance from the last block to each side of the End Point ≥ 25 mm, add other blocks to make sure that most area of Bezel Back can be measured.



Note 2-11: Evaluation test and mass production inspection shall be applied with LED current I_s @ HDR off condition if there is not specified condition.

FT-LCD Module 3.1 Block Diagram

The following shows the block diagram of the 17 inch Color TFT-LCD Module.



3.2 Interface Connection

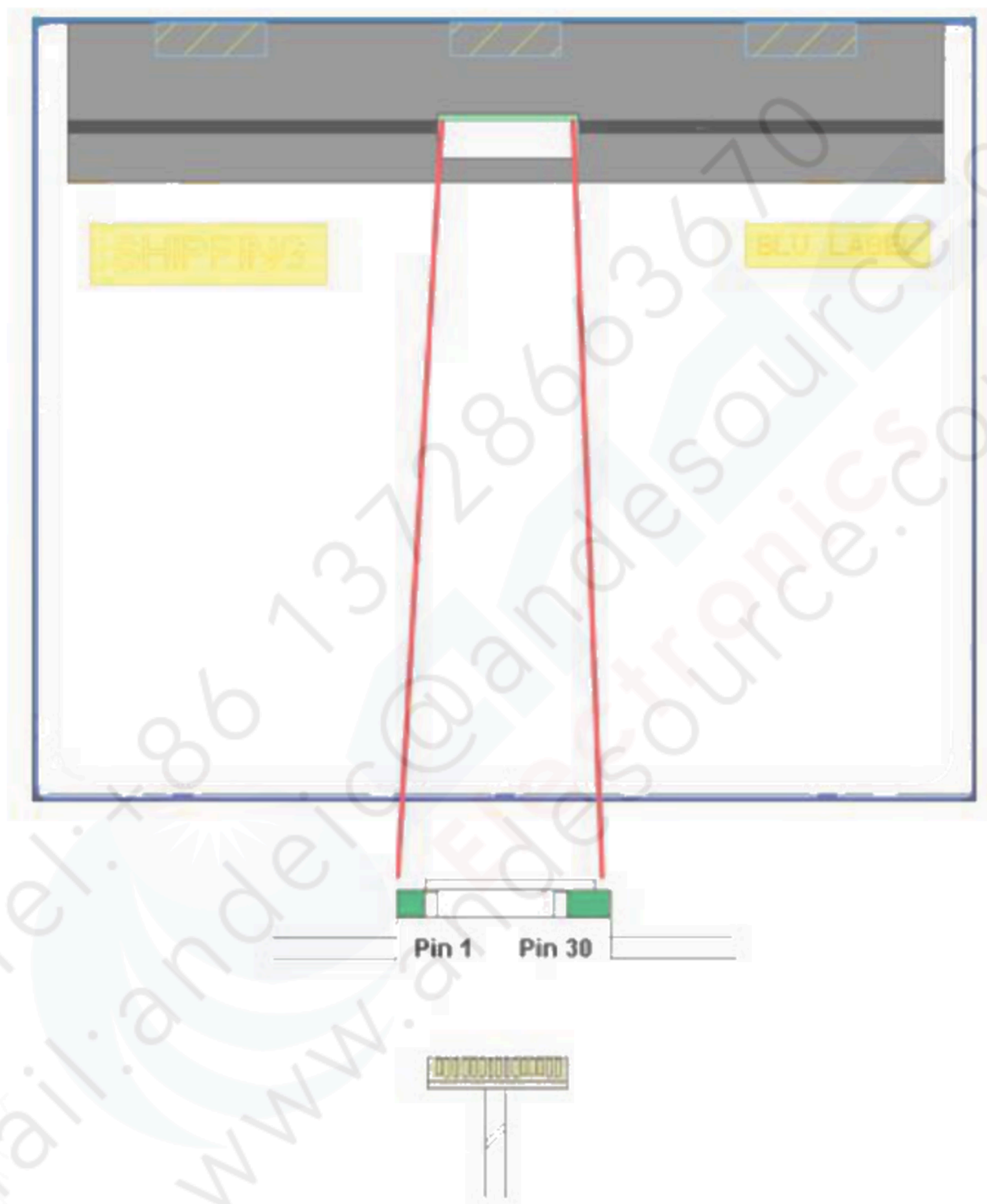
3.2.1 Connector Type

TFT-LCD Connector	Manufacturer	P-TWO	STM
	Part Number	AL230F-A0G1D-P	MSCKT2407P30HB
Mating Connector	Manufacturer	JAE	
	Part Number	FI-X30HL (Locked Type)	

3.2.2 Connector Pin Assignment

PIN #	Symbol	Description	Remark
1	RxO0-	Negative LVDS differential data input (Odd data)	
2	RxO0+	Positive LVDS differential data input (Odd data)	
3	RxO1-	Negative LVDS differential data input (Odd data)	
4	RxO1+	Positive LVDS differential data input (Odd data)	
5	RxO2-	Negative LVDS differential data input (Odd data)	
6	RxO2+	Positive LVDS differential data input (Odd data)	
7	GND	Ground	
8	RxOCLK-	Negative LVDS differential clock input (Odd clock)	
9	RxOCLK+	Positive LVDS differential clock input (Odd clock)	
10	RxO3-	Negative LVDS differential data input (Odd data)	
11	RxO3+	Positive LVDS differential data input (Odd data)	
12	RxE0-	Negative LVDS differential data input (Even data)	
13	RxE0+	Positive LVDS differential data input (Even data)	
14	GND	Ground	
15	RxE1-	Negative LVDS differential data input (Even data)	
16	RxE1+	Positive LVDS differential data input (Even data)	
17	GND	Ground	
18	RxE2-	Negative LVDS differential data input (Even data)	
19	RxE2+	Positive LVDS differential data input (Even data)	
20	RxECLK-	Negative LVDS differential clock input (Even clock)	
21	RxECLK+	Positive LVDS differential clock input (Even clock)	
22	RxE3-	Negative LVDS differential data input (Even data)	
23	RxE3+	Positive LVDS differential data input (Even data)	
24	GND	Ground	
25	NC	No connection (for ADP test only. Do not connect)	

26	NC	No connection (for ADP test only. Do not connect)	
27	NC	No connection (for ADP test only. Do not connect)	
28	VDD	Power Supply Input Voltage	
29	VDD	Power Supply Input Voltage	
30	VDD	Power Supply Input Voltage	



3.3 Electrical Characteristics

3.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

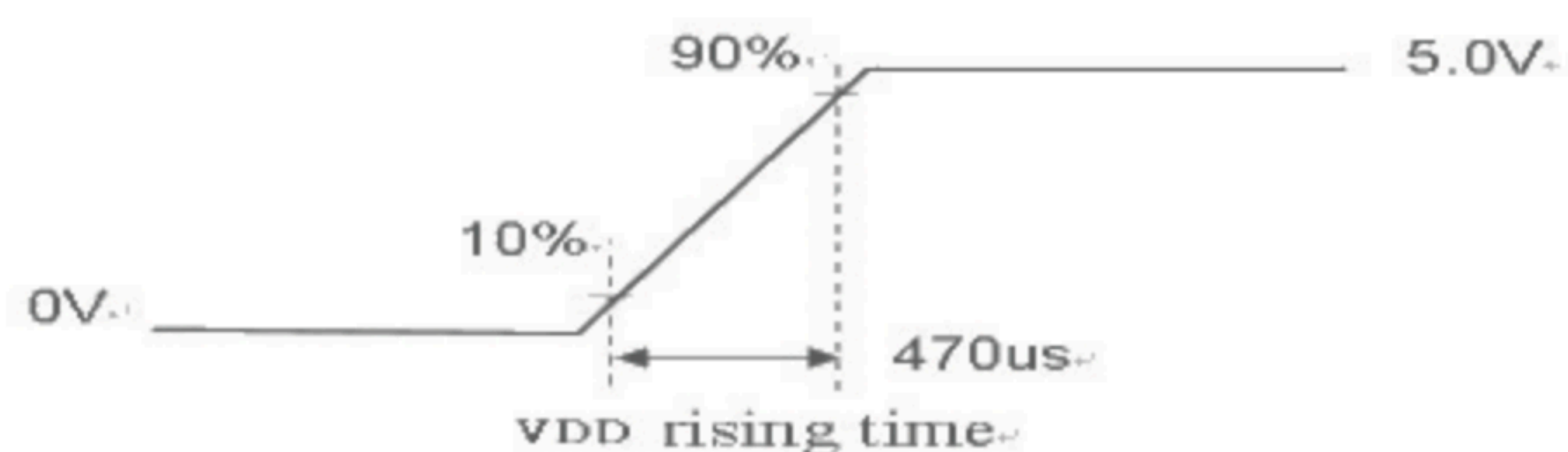
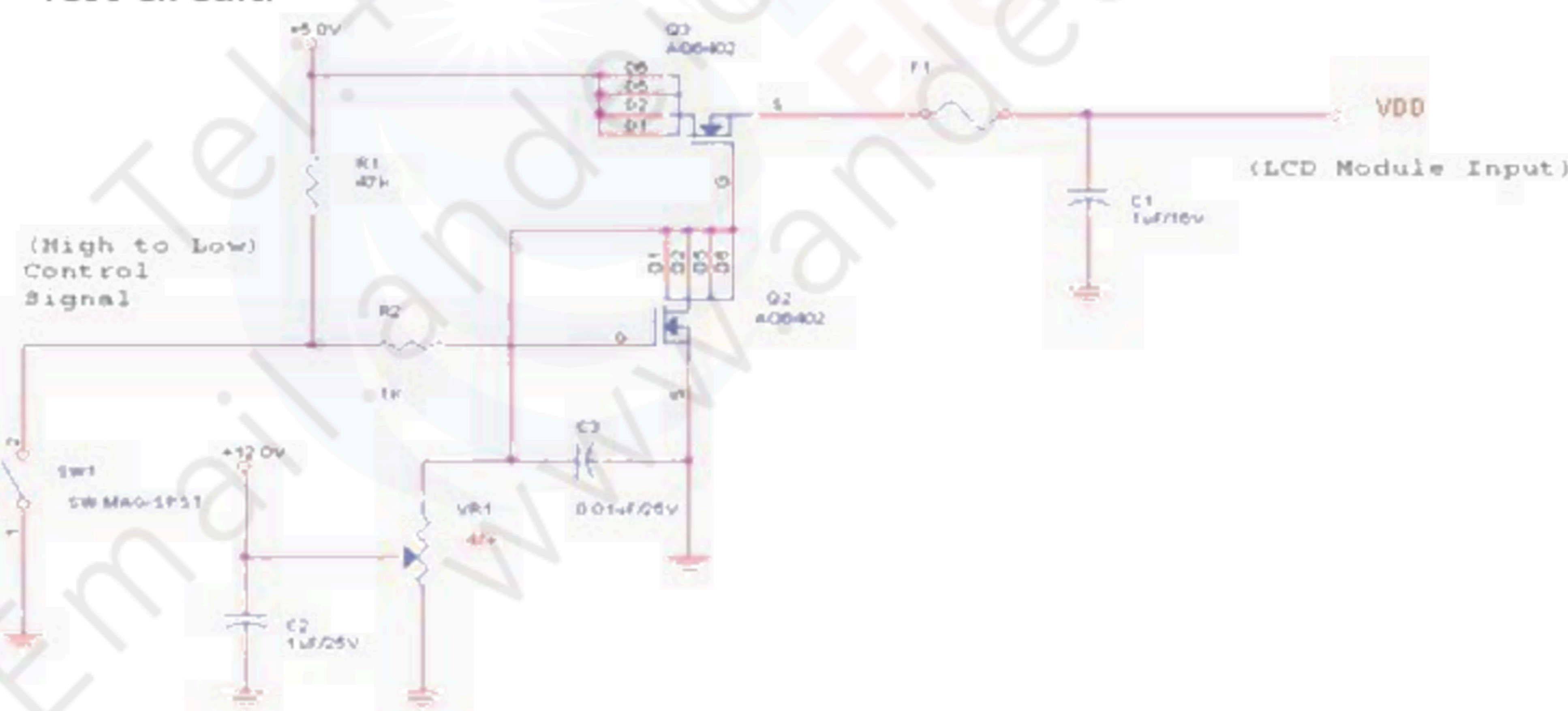
Symbol	Description	Min	Max	Unit	Remark
VDD	Power Supply Input Voltage	GND-0.3	6.0	[Volt]	Ta=25°C

3.3.2 Recommended Operating Condition

Symbol	Description	Min	Typ	Max	Unit	Remark
VDD	Power supply Input voltage	4.5	5.0	5.5	[Volt]	
IDD	Power supply Input Current (RMS)	-	0.6	0.72	[A]	VDD= 5.0V, Black Pattern, Fv=60Hz
			0.72	0.87	[A]	VDD= 5.0V, Black Pattern, Fv=75Hz
PDD	VDD Power Consumption	-	3	3.6	[Watt]	VDD= 5.0V, Black Pattern, Fv=60Hz
			3.6	4.32	[Watt]	VDD= 5.0V, Black Pattern, Fv=75Hz
IRush	Inrush Current	-	-	3.0	[A]	<i>Note 3-1</i>
VDDrp	Allowable VDD Ripple Voltage	-	-	500	[mV]	VDD= 5.0V, Black Pattern, Fv=75Hz

Note 3-1: Inrush Current measurement:

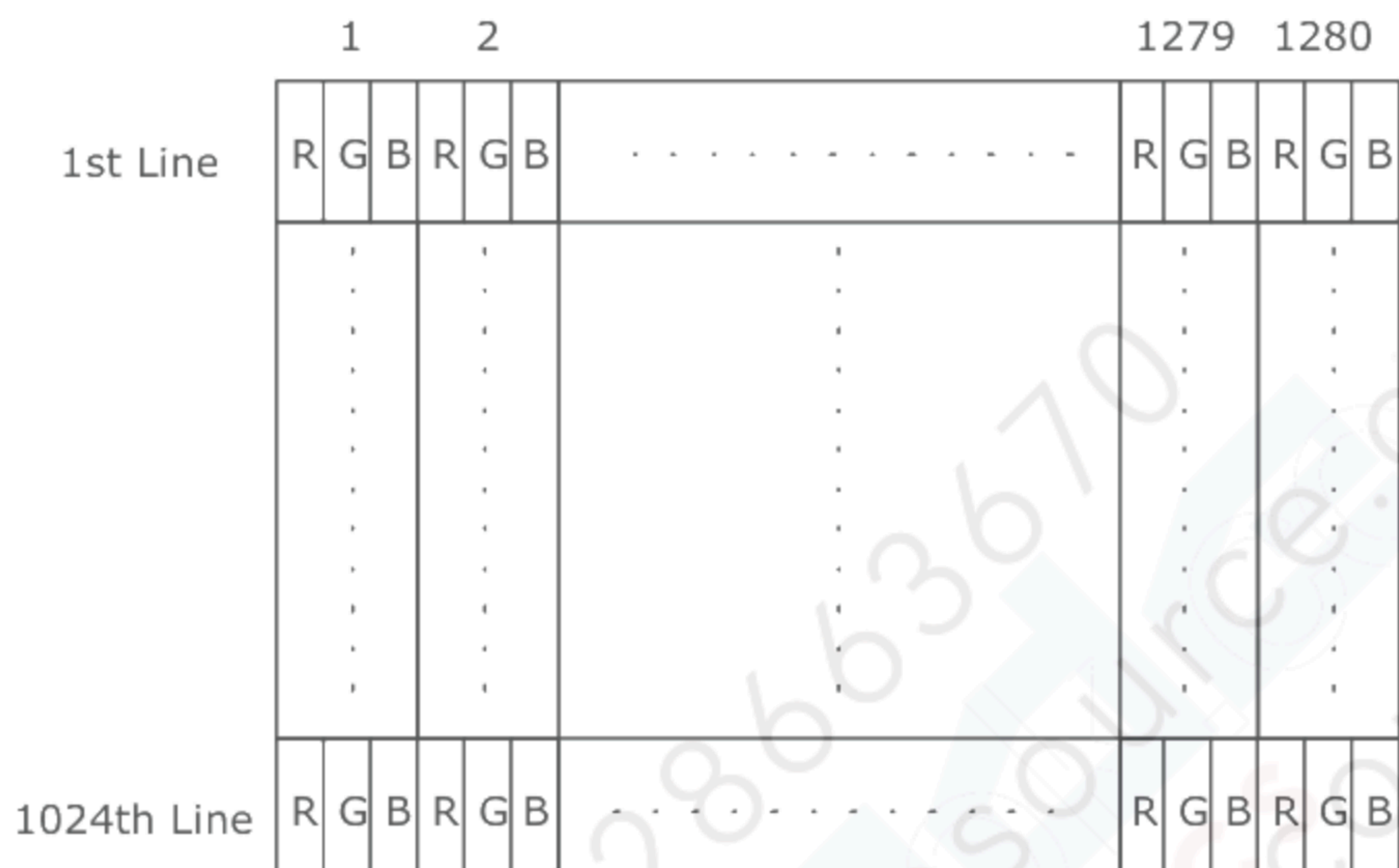
Test circuit:



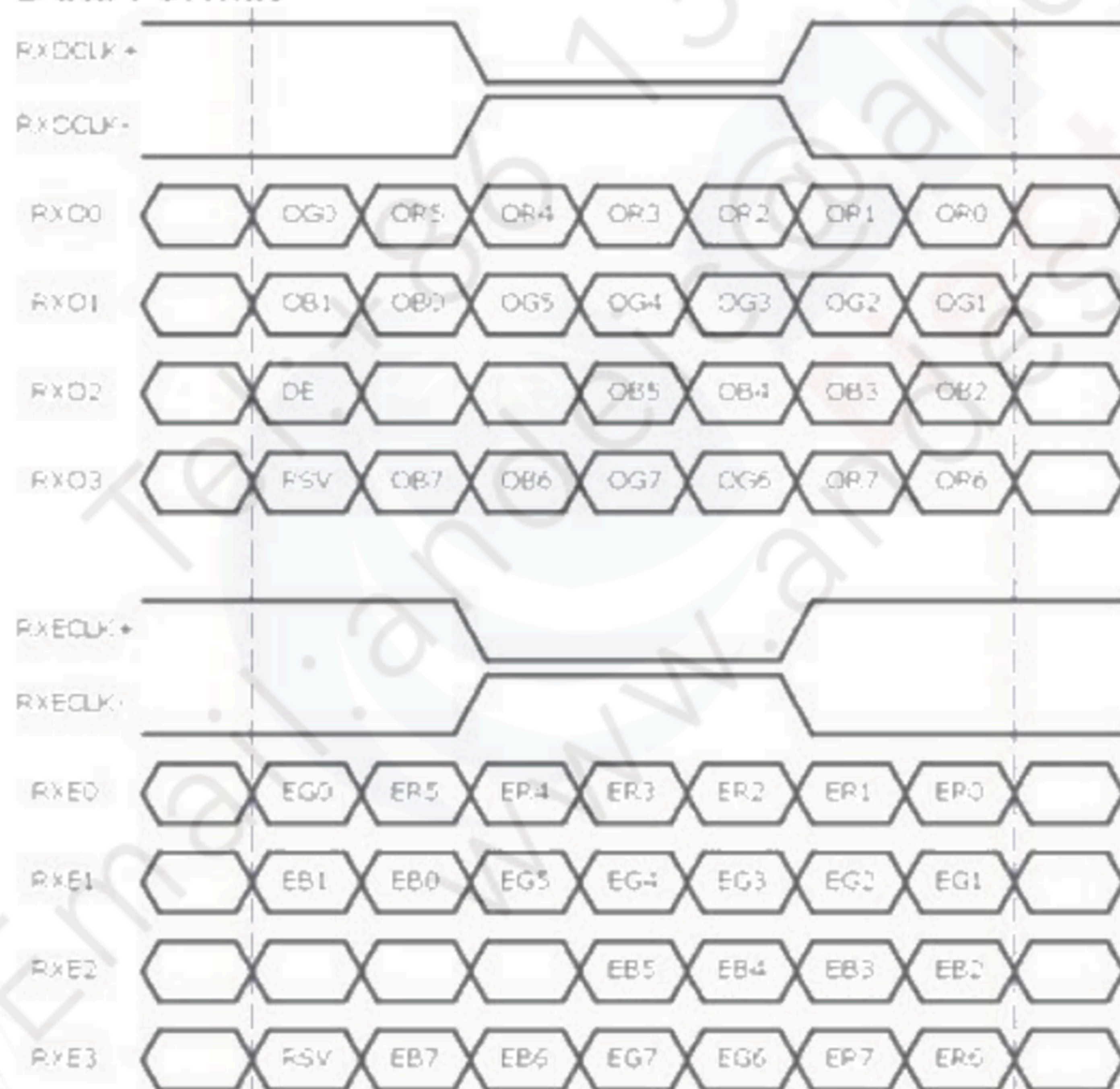
The duration of VDD rising time: 470us.

3.4 Signal Characteristics

3.4.1 LCD Pixel Format



3.4.2 LVDS Data Format



8 Bit Color Bit Order			
MSB	R7	G7	B7
	R6	G6	B6
	R5	G5	B5
	R4	G4	B4
	R3	G3	B3
	R2	G2	B2
	R1	G1	B1
LSB	R0	G0	B0

Note 3-2:

- O = "Odd Pixel Data" E = "Even Pixel Data"
- Refer to 3.4.1 LCD pixel format, the 1st data is 1 (Odd Pixel Data), the 2nd data is 2 (Even Pixel Data) and the last data is 1280 (Even Pixel Data).

3.4.3 Color versus Input Data

The following table is for color versus input data (8bit). The higher the gray level, the brighter the color.

Color	Gray Level	Color Input Data																								Remark
		RED data (MSB:R7, LSB:R0)								GREEN data (MSB:G7, LSB:G0)								BLUE data (MSB:B7, LSB:B0)								
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0	
Black	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
Gray 127	-	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	
Red	L0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
Green	L0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	
Blue	L0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	

3.4.4 LVDS Specification

a. DC Characteristics:

Symbol	Description	Min	Typ	Max	Units	Condition
V_{TH}	LVDS Differential Input High Threshold	-	-	+100	[mV]	$V_{CM} = 1.2V$
V_{TL}	LVDS Differential Input Low Threshold	-100	-	-	[mV]	$V_{CM} = 1.2V$
$ V_{ID} $	LVDS Differential Input Voltage	100	-	600	[mV]	
V_{CM}	LVDS Common Mode Voltage	+1.0	+1.2	+1.5	[V]	$V_{TH}-V_{TL} = 200mV$

LVDS Signal Waveform:
Use RxOCLK- & RxOCLK+ as example.

Single-End

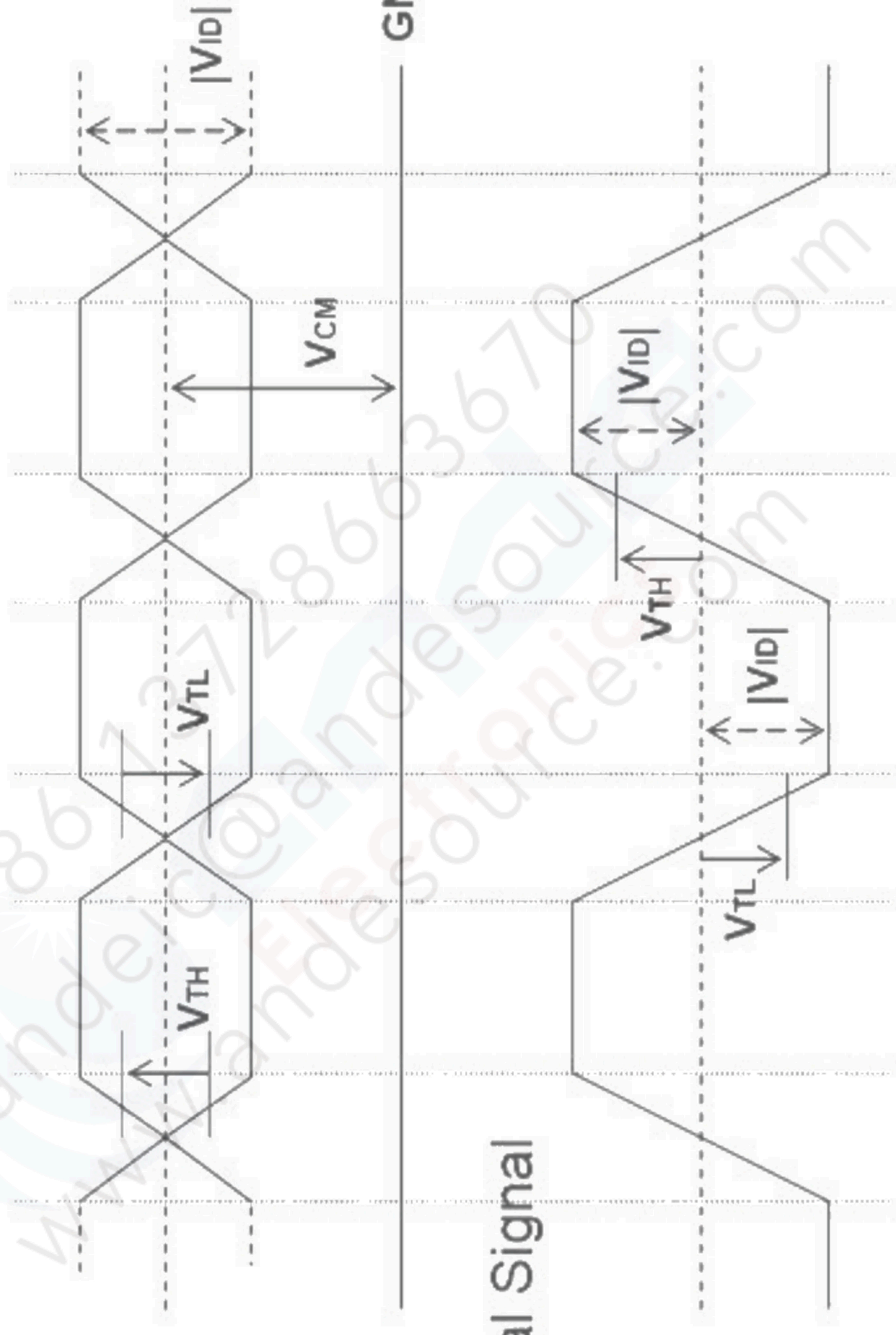
RxOCLK-

RxOCLK+

GND

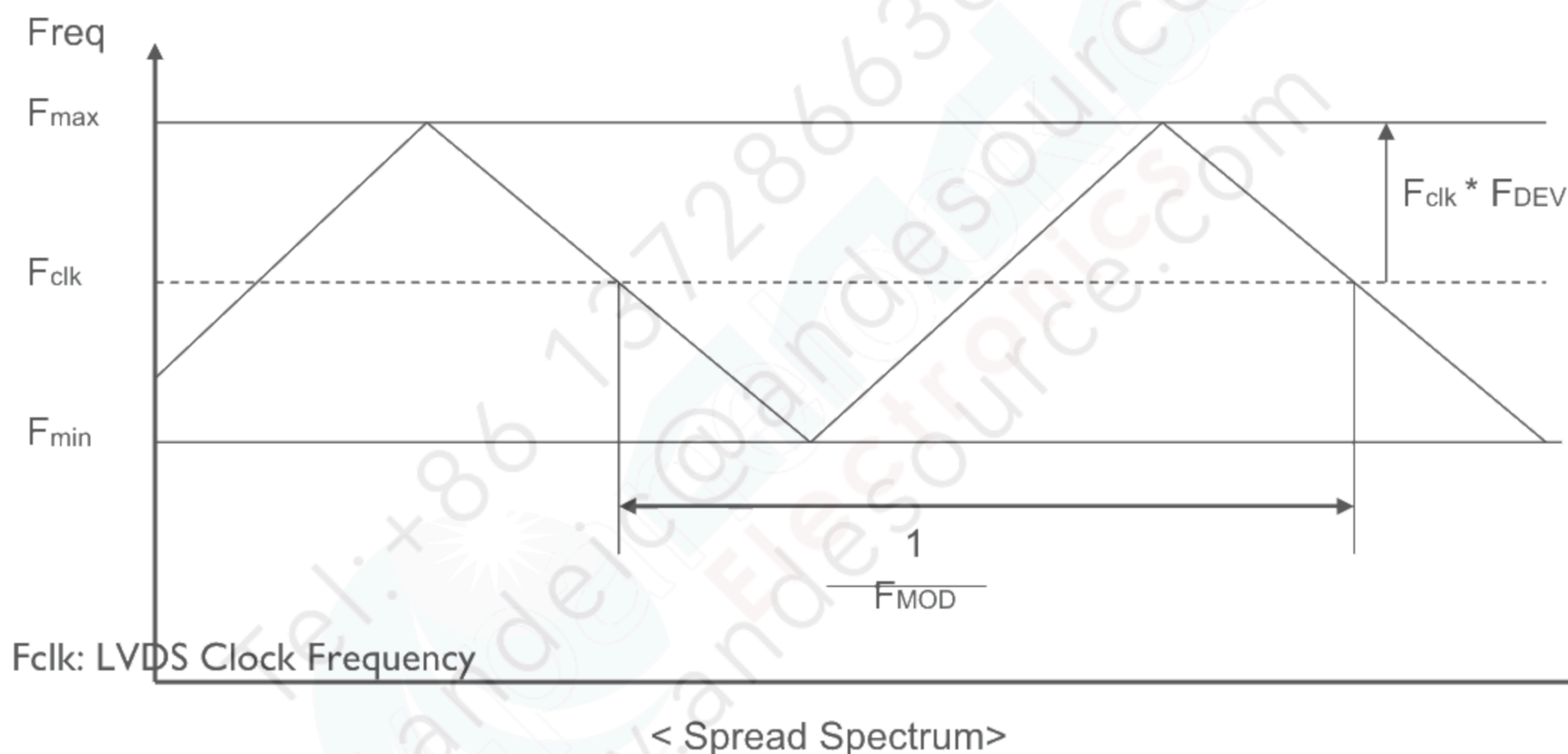
Differential Signal

0V



b. AC Characteristics:

Symbol	Description	Min	Max	Unit	Remark
F_{DEV}	Maximum deviation of input clock frequency during Spread Spectrum	-	± 3	%	
F_{MOD}	Maximum modulation frequency of input clock during Spread Spectrum	-	200	KHz	



3.4.5 Input Timing Specification

It only support DE mode, and the input timing are shown as the following table.

Symbol	Description		Min.	Typ.	Max.	Unit	Remark
T_v	Vertical Section	Period	1036	1066	1873	Th	
$T_{disp}(v)$		Active	1024	1024	1024	Th	
$T_{blk}(v)$		Blanking	12	42	849	Th	

Fv		Frequency	50	60	76	Hz	
Th	Horizontal Section	Period	730	844	1320	Tclk	
Tdisp (h)		Active	640	640	640	Tclk	
Tblk (h)		Blanking	90	204	680	Tclk	
Fh		Frequency	51.8	64	93.7	KHz	Note 3-3
Tclk	LVDS Clock	Period	14.6	18.5	26	ns	1/Fclk
Fclk		Frequency	37.8	54	68.4	MHz	Note 3-4

Note 3-3: The equation is listed as following. Please don't exceed the above recommended value.

$$Fh (Min.) = Fclk (Min.) / Th (Min.);$$

$$Fh (Typ.) = Fclk (Typ.) / Th (Typ.);$$

$$Fh (Max.) = Fclk (Max.) / Th (Min.);$$

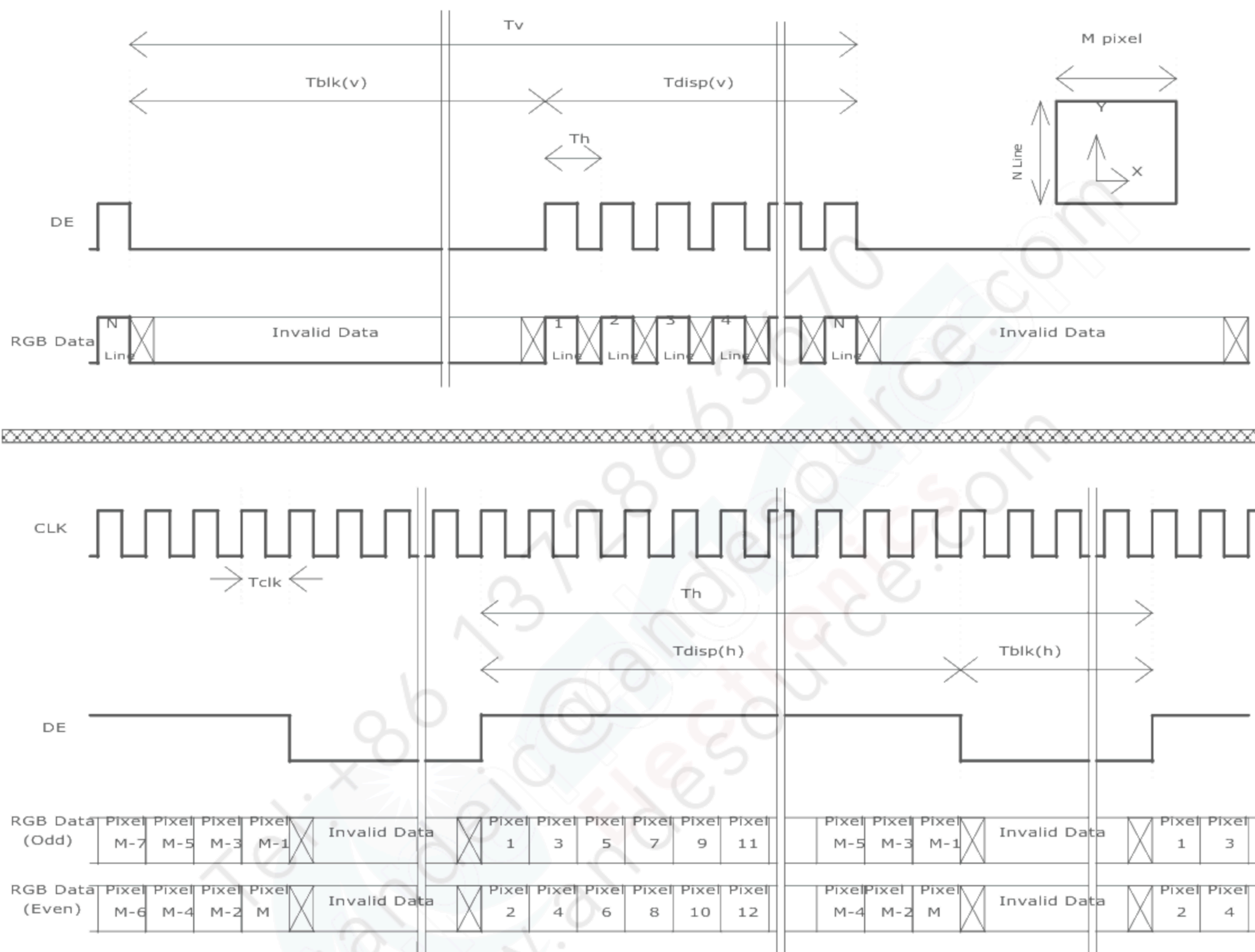
Note 3-4: The equation is listed as following. Please don't exceed the above recommended value.

$$Fclk (Min.) = Fv (Min.) \times Th (Min.) \times Tv (Min.);$$

$$Fclk (Typ.) = Fv (Typ.) \times Th (Typ.) \times Tv (Typ.);$$

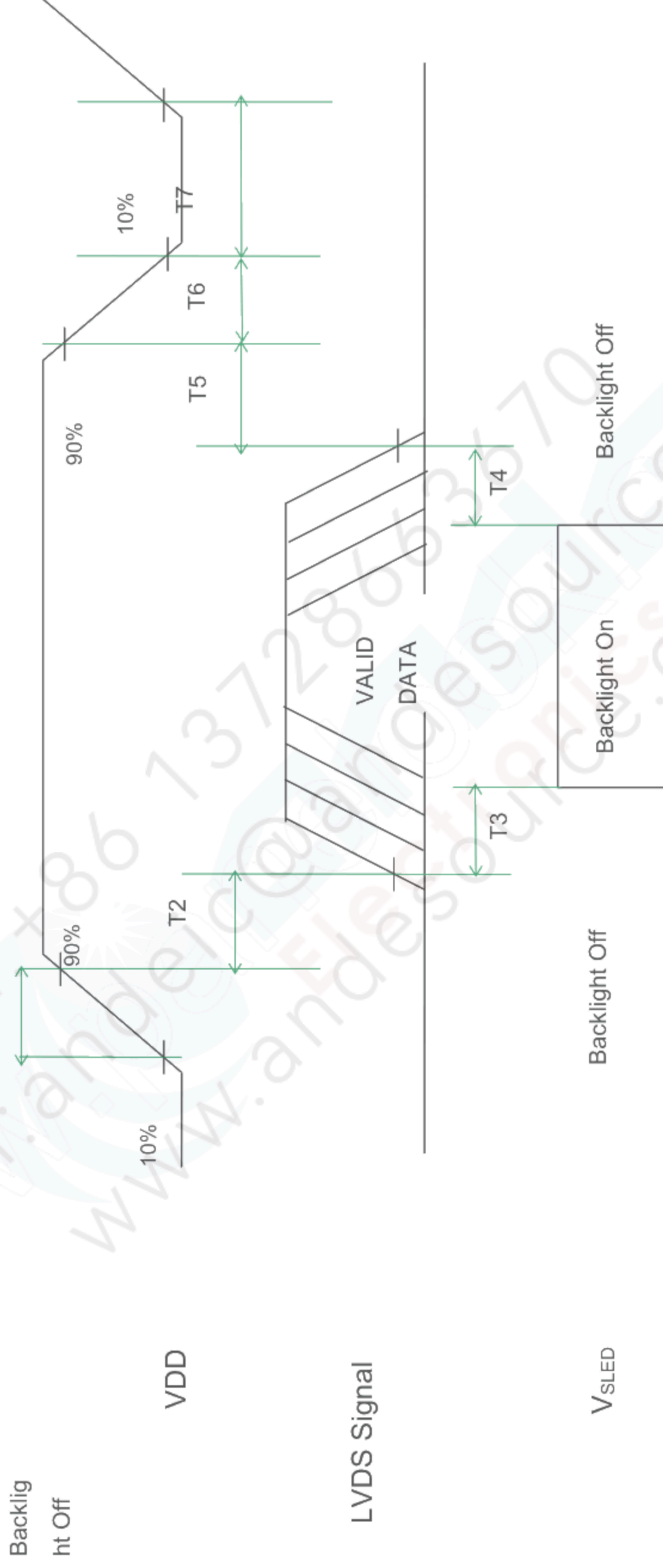
$$Fclk (Max.) = Fv (Max.) \times Th (Typ.) \times Tv (Typ.);$$

3.4.6 Input Timing Diagram



3.5 Power ON/OFF Sequence

VDD power, LVDS signal and backlight on/off sequence are as following. LVDS signals from any system shall be Hi-Z state when VDD is off.



Power Sequence Timing

Symbol	Value			Unit	Remark
	Min.	Typ.	Max.		
T1	0.5	-	10	[ms]	
T2	0	-	50	[ms]	
T3	500	-	-	[ms]	
T4	100	-	-	[ms]	<i>Note 3-8</i>
T5	0		50	[ms]	<i>Note 3-6</i> <i>Note 3-7</i>
T6	0	-	150	[ms]	
T7	1000	-	-	[ms]	

Note 3-6 : Recommend setting T5 = 0ms to avoid electronic noise when VDD is off.

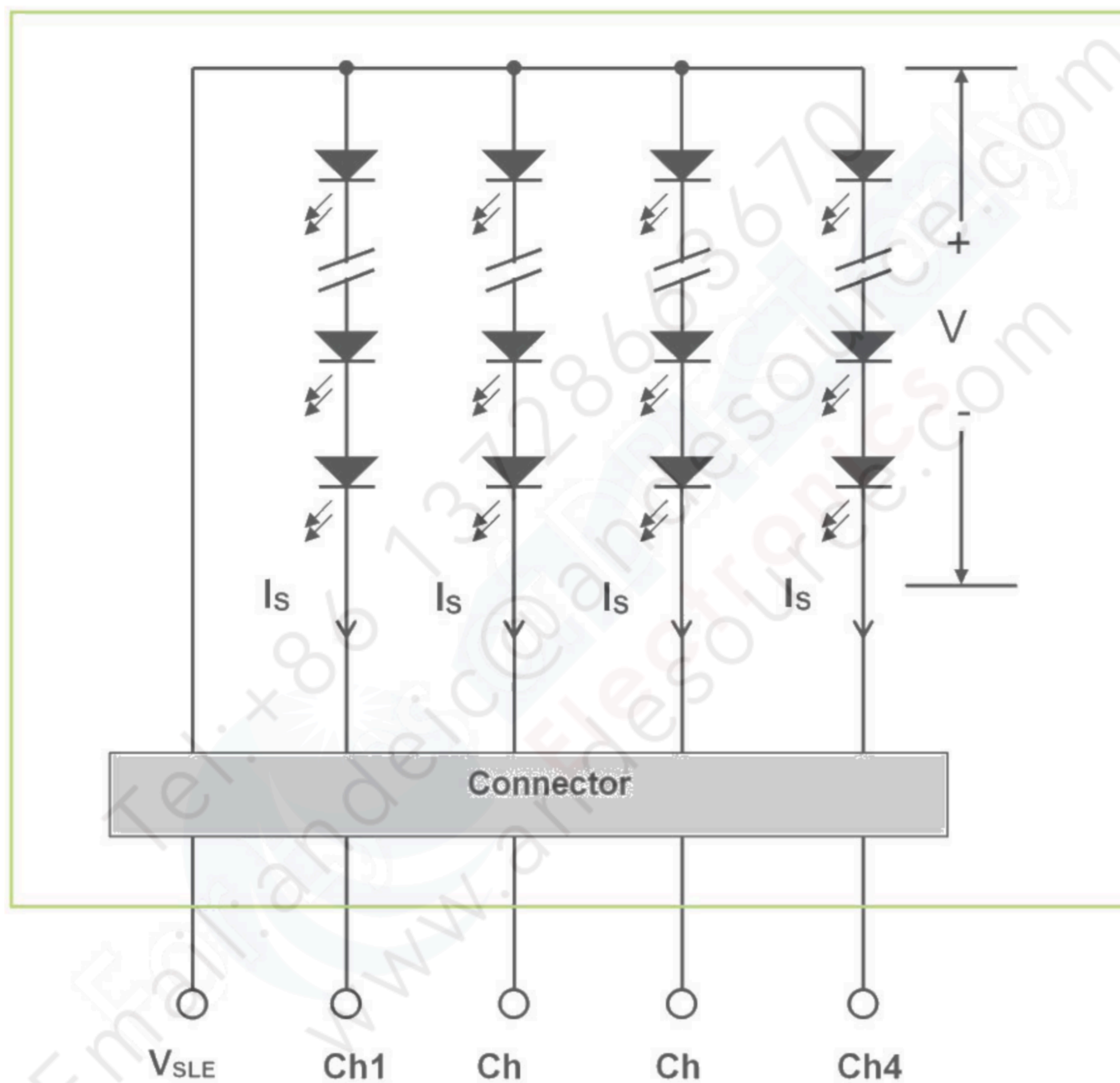
Note 3-7 : During T5 period , please keep the level of input LVDS signals with Hi-Z state.

Note 3-8 : If T4 < 100ms, there will be no reliability concern, but the display may momentarily show abnormal screen.

4 Backlight Unit

4.1 Block Diagram

The following shows the block diagram of the 17 inch Backlight Unit. And it includes 36 pcs LED in the LED light bar. (4 strings and 9 pcs LED of one string).



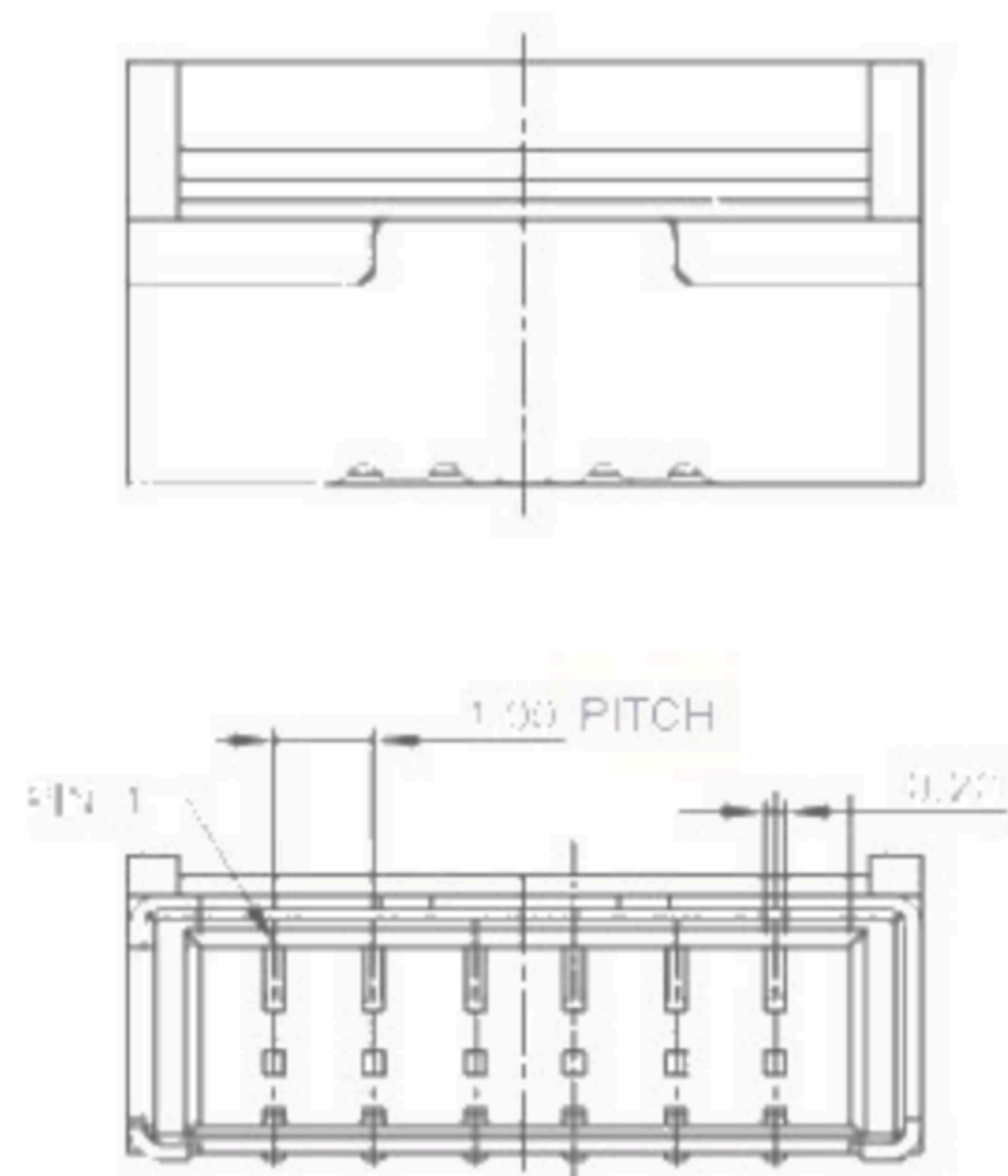
4.2 Interface Connection

4.2.1 Connector Type

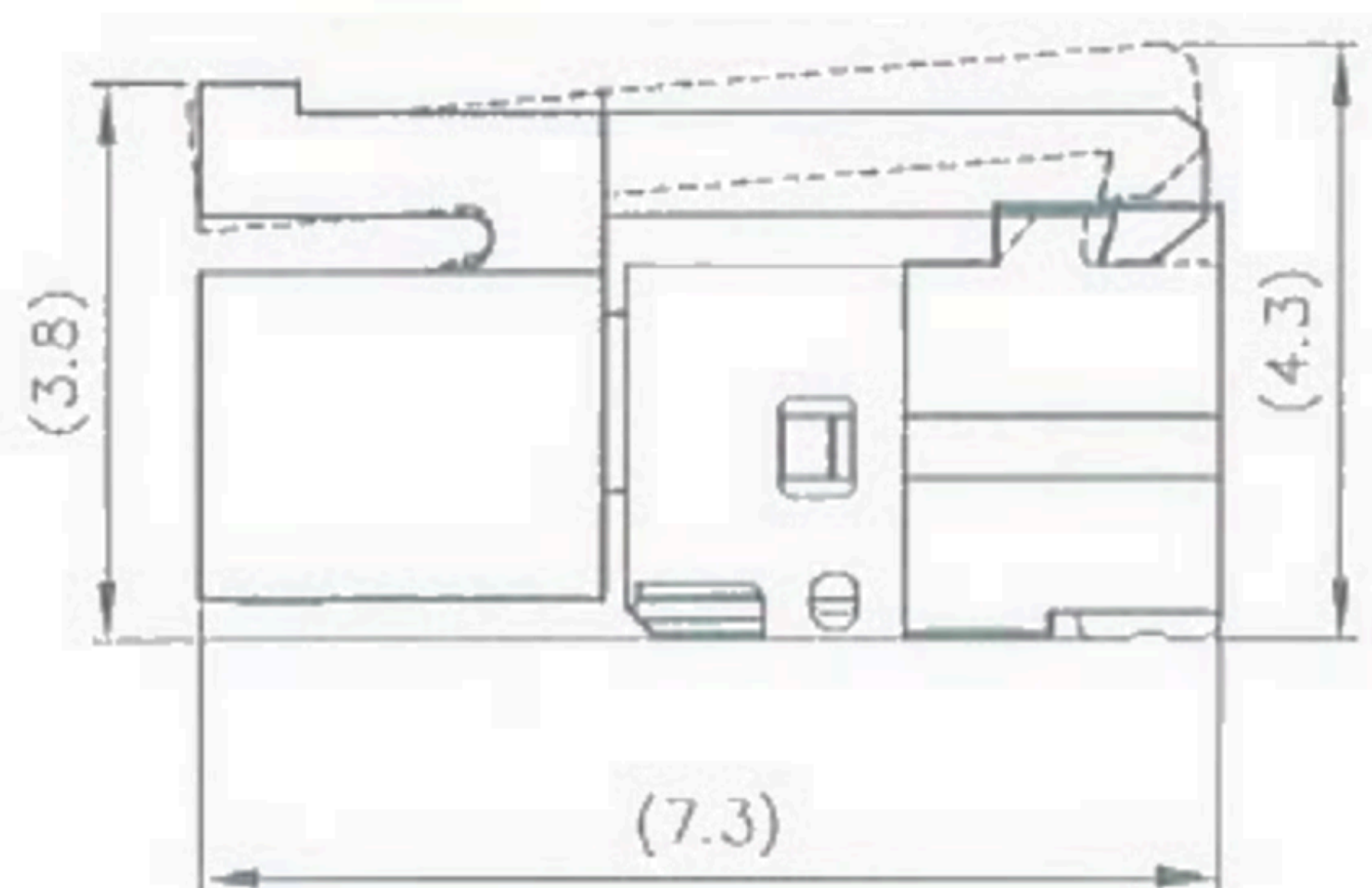
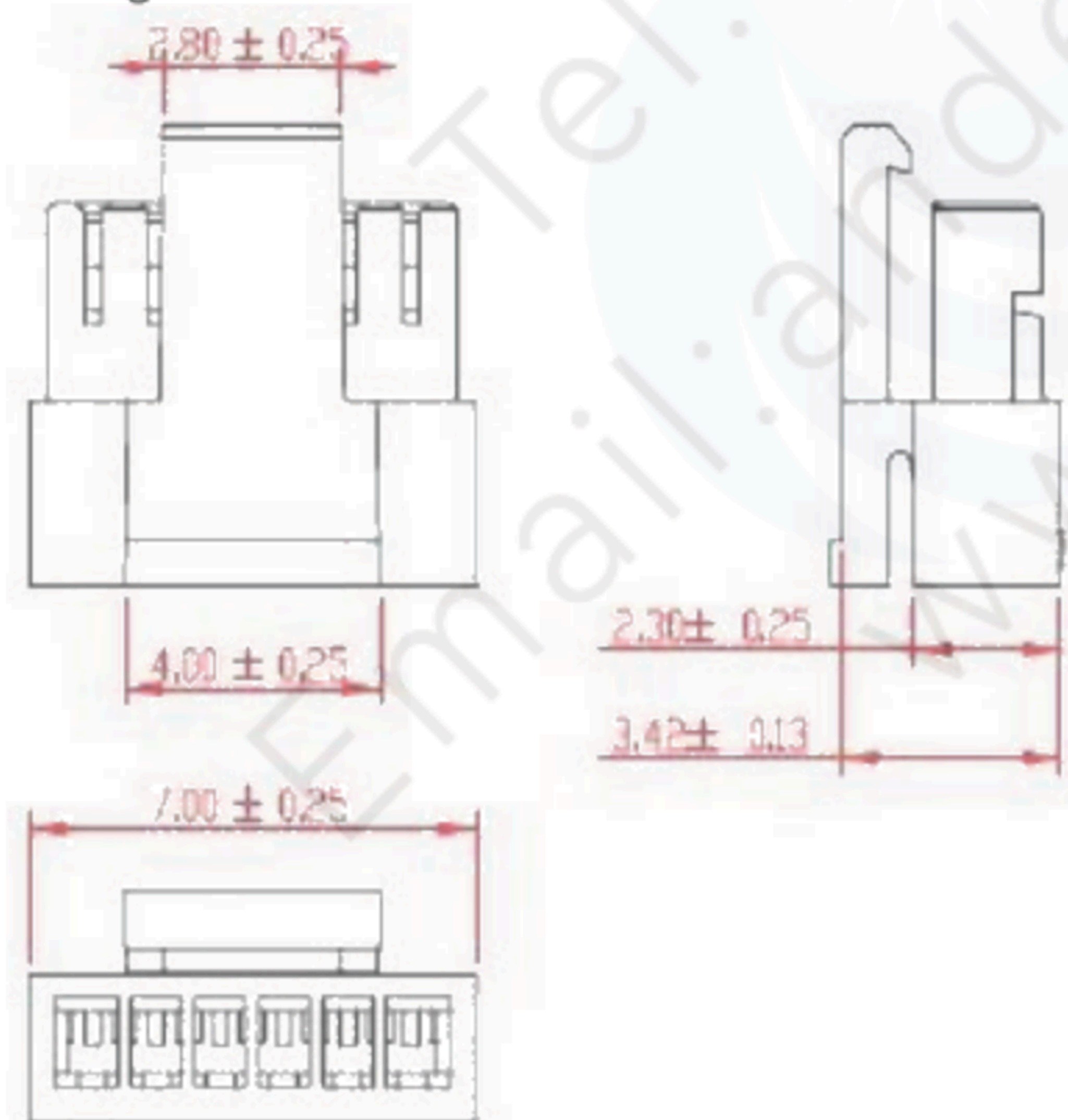
Backlight Connector	Manufacturer	ENTERY
	Part Number	3707K-S06N-21R
Mating Connector	Manufacturer	Cvilux
	Part Number	CII406SL000-NH (Locking type)

Backlight Connector dimension:

$H \times V \times D = 13.9 \times 3.00 \times 4.25$, Pitch = 1.0(unit = mm)

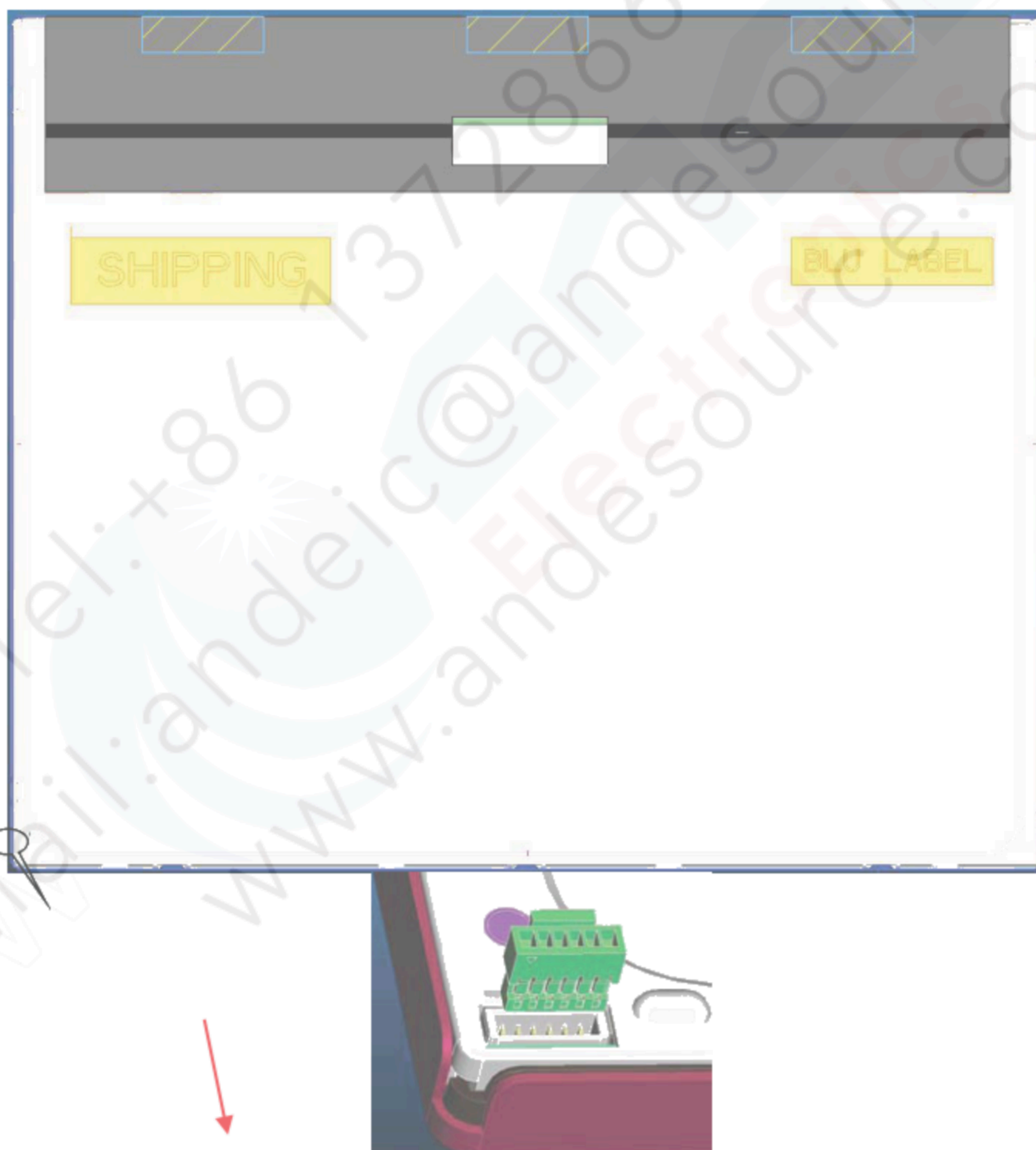


Mating Connector dimension:



4.2.2 Connector Pin Assignment

Pin#	Symbol	Description	Remark
1	Ch1	LED Current Feedback Terminal (Channel 1)	
2	Ch2	LED Current Feedback Terminal (Channel 2)	
3	V _{SLED}	LED Power Supply Voltage Input Terminal	
4	V _{SLED}	LED Power Supply Voltage Input Terminal	
5	Ch3	LED Current Feedback Terminal (Channel 3)	
6	Ch4	LED Current Feedback Terminal (Channel 4)	



4.3 Electrical Characteristics

4.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

(Ta=25°C)

Symbol	Description	Min	Max	Unit	Remark
Is	LED String Current	0	120	[mA]	100% duty ratio

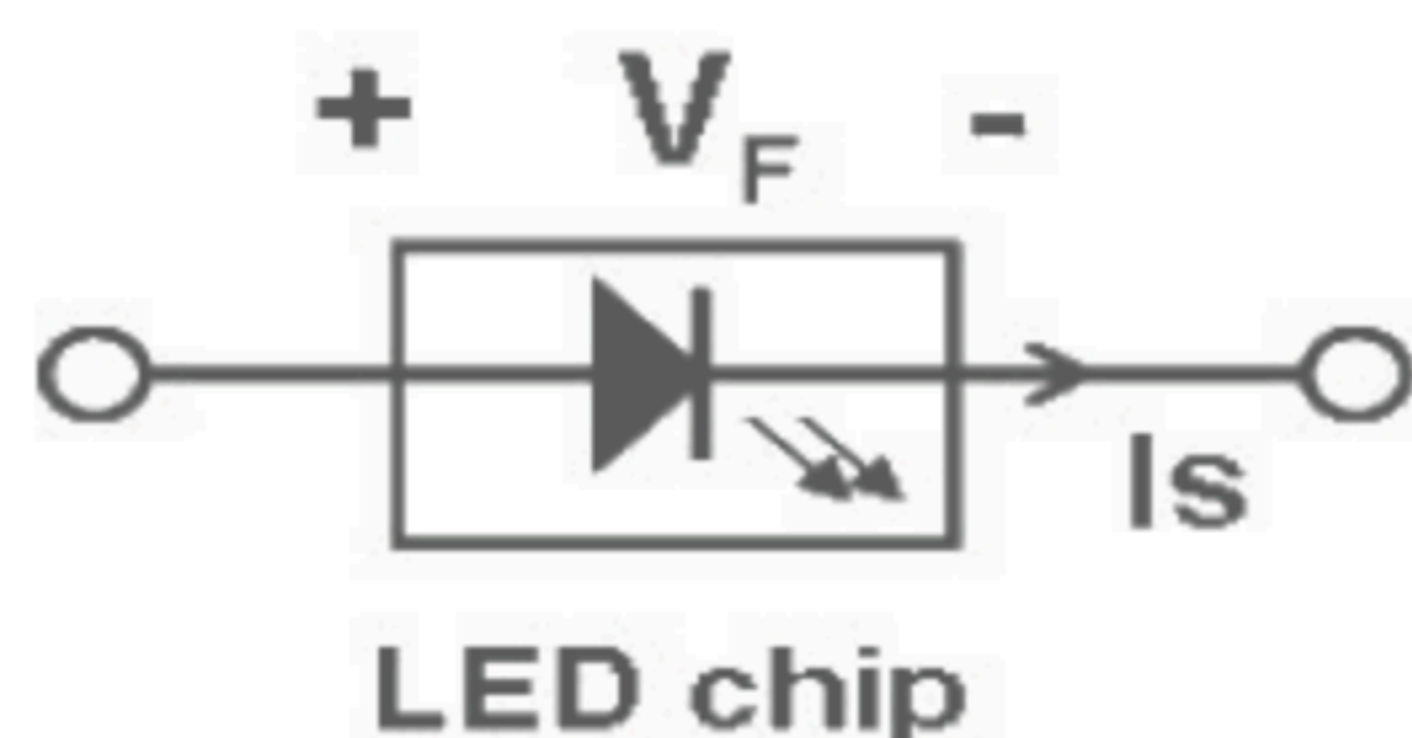
4.3.2 Recommended Operating Condition

(Ta=25°C)

Symbol	Description	Min.	Typ.	Max.	Unit	Remark
Is	LED String Current	-	45	49.5	[mA]	100% duty ratio of LED chip <i>Note 4-6</i>
Vs	LED String Voltage	23.0	24.8	26.6	[Volt]	Is=45mA@100% duty ratio; <i>Note 4-1</i> <i>Note 4-5, Note 4-7</i>
ΔVs	Maximum Vs Voltage Deviation of light bar	-	-	1.8	[Volt]	Is=45mA@100% duty ratio; <i>Note 4-2</i>
PBLU	LED Light Bar Power Consumption	-	4.5	4.8	[Watt]	<i>Note 4-3</i>
LT _{LED}	LED Life Time	30,000	-	-	[Hour]	<i>Note 4-4</i>
OVP	Over Voltage Protection in system board	110% Vs(Max.)			[Volt]	<i>Note 4-5</i>
IFp	LED Pulse Forward Current		180		[mA]	<i>Duty ≤ 10%</i> <i>Pulse time within 10 ms</i>
IFp	LED Pulse Forward Current		142.5		[mA]	<i>Duty ≤ 24%</i> <i>Pulse time within 10 ms</i>
IFp	LED Pulse Forward Current		135		[mA]	<i>Duty ≤ 30%</i> <i>Pulse time within 10 ms</i>
IFp	LED Pulse Forward Current		86.25		[mA]	<i>Duty ≤ 75%</i> <i>Pulse time within 10 ms</i>

Note 4-1: $V_s (\text{Typ.}) = V_F (\text{Typ.}) \times \text{LED No. (one string)}$;

- V_F : LED chip forward voltage, $V_F (\text{Min.})=2.56 \text{ V}$, $V_F (\text{Typ.})=2.76 \text{ V}$, $V_F (\text{Max.})=2.96 \text{ V}$
- The same equation to calculate $V_s (\text{Min.})$ & $V_s (\text{Max.})$ for respective $V_F (\text{Min.})$ & $V_F (\text{Max.})$;



Note 4-2: $\Delta V_s (\text{Max.}) = \Delta V_F \times \text{LED No. (one string)}$;

- ΔV_F : LED chip forward voltage deviation; (0.2 V , each Bin of LED V_F)

Note 4-3: $P_{\text{BLU}} (\text{Typ.}) = V_s (\text{Typ.}) \times I_s (\text{Typ.}) \times 4$; (4 is total String No. of LED Light bar)

$$P_{\text{BLU}} (\text{Max.}) = V_s (\text{Max.}) \times I_s (\text{Typ.}) \times 4 ;$$

Note 4-4: Definition of life time:

- Brightness of LED becomes to 50% of its original value
- Test condition: $I_s = 45 \text{ mA}$ and 25°C (Room Temperature)

Note 4-5: Recommendation for LED driver power design:

Due to there are electrical property deviation in LED & monitor set system component after long time operation. ADP strongly recommend the design value of LED driver board OVP (over voltage protection) should be 10% higher than max. value of LED string voltage (V_s) at least.

Note 4-6: ADP strongly recommend “Analog Dimming” method for backlight brightness control for Wavy Noise Free. Otherwise, recommend that Dimming Control Signal (PWM Signal) should be synchronized with Frame Frequency.

Note 4-7 Ensure that the LED light bar is not subjected either forward or reverse voltage while monitor set is on standby mode or not in use.

5 Reliability Test

ADP reliability test items are listed as following table. (*Bare Panel only*)

Items	Condition	Remark
Temperature Humidity Bias (THB)	$T_a = 50^\circ\text{C}$, 80%RH, 300hours	
High Temperature Operation (HTO)	$T_a = 50^\circ\text{C}$, 50%RH, 300hours	
Low Temperature Operation (LTO)	$T_a = 0^\circ\text{C}$, 300hours	
High Temperature Storage (HTS)	$T_a = 60^\circ\text{C}$, 300hours	

Low Temperature Storage (LTS)	Ta= -20℃, 300hours	
Vibration Test (Non-operation)	Acceleration: 1.5 Grms Wave: Random Frequency: 10 - 200 Hz Sweep: 30 Minutes each Axis (X, Y, Z)	
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 20 ms Direction: ±X, ±Y, ±Z (one time for each Axis)	
Thermal Shock Test (TST)	-20℃/30min, 60℃/30min, 100 cycles	Note 5-1
On/Off Test	On/10sec, Off/10sec, 30,000 cycles	
ESD (Electro Static Discharge)	Contact Discharge: ± 15KV, 150pF(330Ω) 1sec, 8 points, 25 times/ point.	Note 5-2
	Air Discharge: ± 15KV, 150pF(330Ω) 1sec 8 points, 25 times/ point.	
Altitude Test	Operation: 18,000 ft Non-Operation: 40,000 ft	

Note 5-1: a. A cycle of rapid temperature change consists of varying the temperature from -20℃ to 60℃, and back again. Power is not applied during the test.

b. After finish temperature cycling, the unit is placed in normal room ambient for at least 4 hours before power on.

Note 5-2: EN61000-4-2, ESD class B: Certain performance degradation allowed

No data lost
Self-recoverable
No hardware failures.

ESD discharged points should avoid display area and periphery front bezel of display area. Suggest points were 4 side parallel edge of display area surface.
Metal front bezel must cover half area of BM (black matrix), and metal front bezel must connect with metal back bezel to protect source IC of panel by ESD damaged.

Note 5-3: Result Evaluation Criteria:

TFT-LCD panels test should take place after gradually cooling enough at room temperature
In the normal application, there should be no particular problems that may affect the display function.

6 Shipping Label

Definition of Label

XXXXXXXXXXXX-XXXX

	Manufactured XX/XX Model No: P170ETN AU Optronics MADE IN XXXXXX (XX)	   
XXXXXXXXXXXX-XXXX  XXXXXXXXXXXXXXXXXXXX		

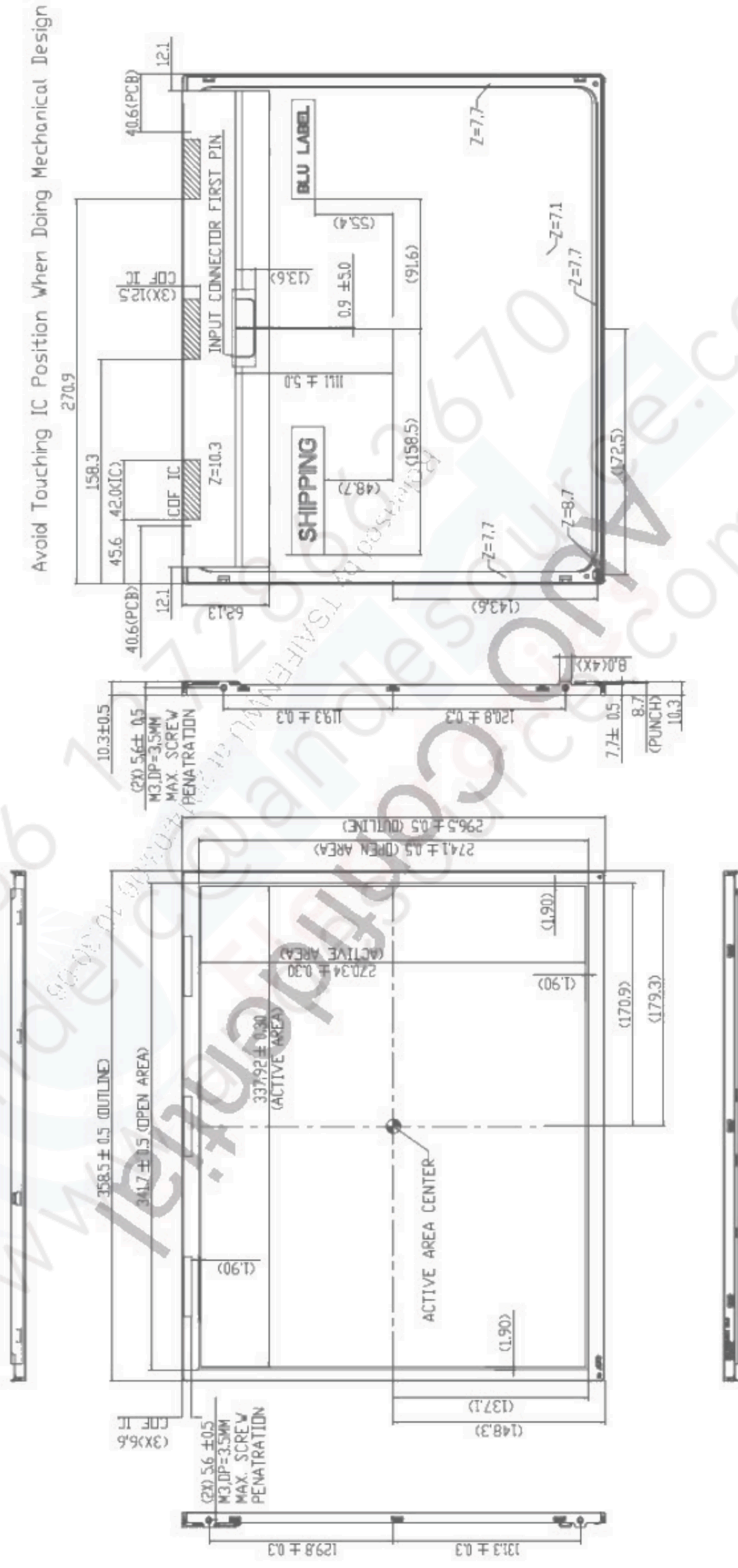
- (1) For Pb Free Product, ADP will add  for identification.
- (2) For RoHS compatible products, ADP will add  for identification.
- (3) For "Cadmium Free product, ADP will add  for identification.
- (4) Note: The green Mark will be present only when the green documents have been ready by ADP internal green team. (Definition of green design follows the ADP green design checklist.)

B. Carton Label:

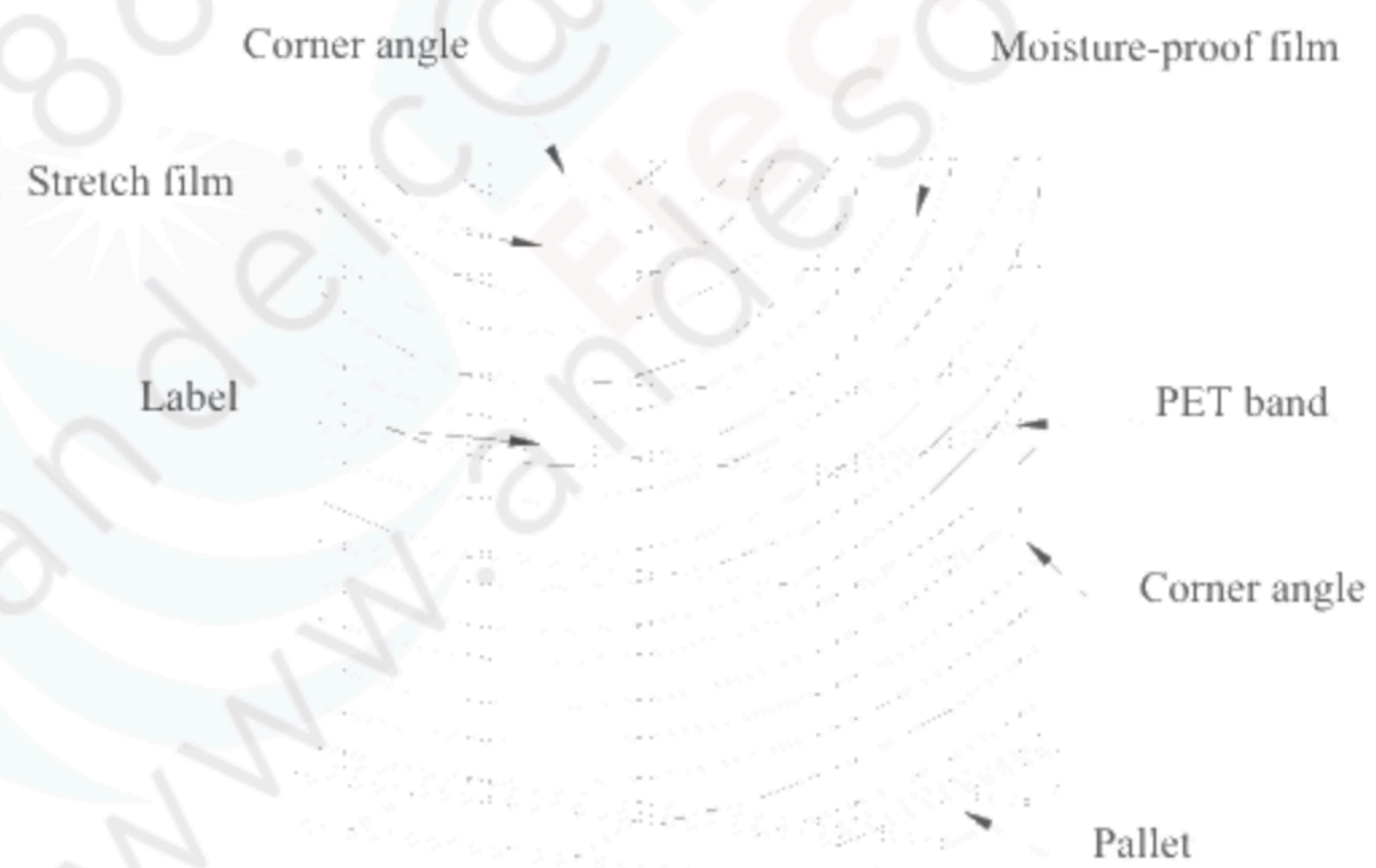
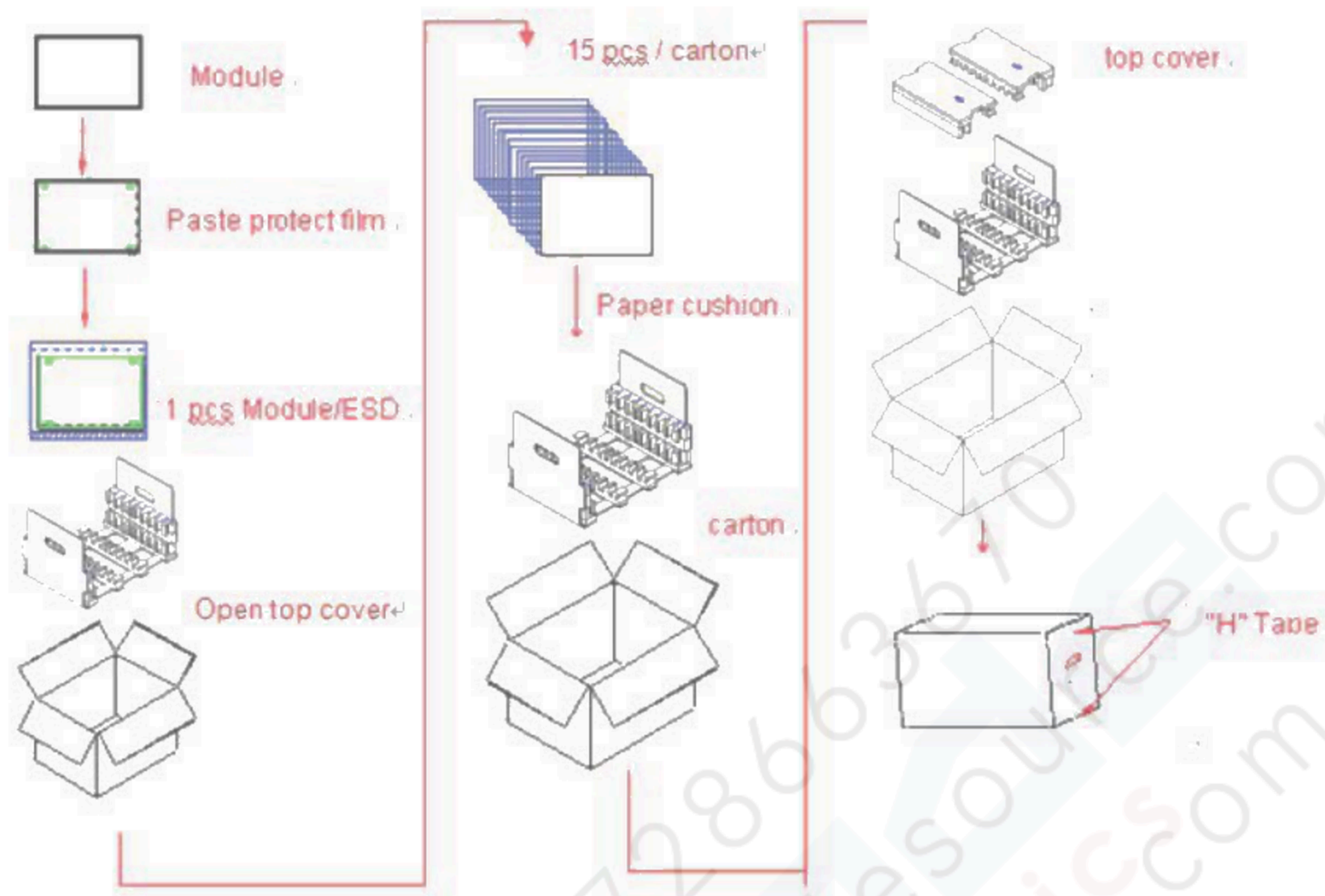
AU Optronics	QTY: -		
MODEL NO: - - - - -			
PART NO: - - - - -			
CUSTOMER NO: XXXXX-XXXXX-XXXXX			
CARTON NO:			
Made in XXXXXX	*XXXXXXXXXXXX-XXXX*		

- Note:
- 1.TORQUE OF (4X) M3 USER HOLE BOSS SHOULD BE WITHIN 4 kg-cm AND RE-SCREW 10 TIMES.
 - 2.LED CONNECTOR IS 3707K-S06N-2(RKE&T) OR EQUIVALENT
 - 3.TOLERANCE UNDEFINED TO BE $\pm 0.5\text{mm}$.
 - 4.THE DIMENSION EXCLUDES DEFORMATION.
 - 5.MODULE THICKNESS TO BE 10.8MM MAX.
 - 6.LVDS CONNECTOR TO BE JAE FI-XB30SSRLAHF16.

Avoid touching COF position when doing mechanical design



8.1 Packing Flow



8.2 Pallet and shipment information

ADP-General

Item	Specification			Remark
	Q'ty	Dimension	Weight(kg)	
Panel	1	358.5(H)mm × 296.5(V)mm × 10.3(D)mm	1.273	
Cushion	1	-	1.150	
Box	1	416(L)mm × 390(W)mm × 377(H)mm	0.860	without Panel & cushion
Packing Box	15pcs/Box	416(L)mm × 390(W)mm × 377(H)mm	21.105	with panel & cushion
Pallet	1	1180(L)mm × 890(W)mm × 132(H)mm	14.10	
Pallet after Packing	18 boxes/pallet	1180(L)mm × 890(W)mm × 1263 (H)mm	394	